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April 1st, 2010
Renesas Electronics Corporation

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740 Family

740 Family Sample Programs Collection

Contents

1.	Distinctive Features of 740 Family Instruction Set.....	2
2.	Effective use of 740 Family MCU Distinctive Instructions	3
2.1	Memory-to-Memory Operations	3
2.2	Bit Branch Instructions	5
2.3	Bit Managing (Set/Reset).....	7
2.4	Rotate Shift	8
3.	Basic Processing Program Example	11
3.1	RAM Clear.....	11
3.2	Data Transfer (RAM).....	13
3.3	Data Transfer (ROM address fixed).....	15
3.4	Data Transfer (ROM address variable).....	17
3.5	Data Sort.....	20
3.6	16-Bit Data Add (Binary)	25
3.7	16-Bit Data Subtract (Binary)	27
3.8	16-Bit Data Add (BCD).....	28
3.9	16-Bit Subtract (BCD)	31
3.10	16-Bit Data Multiply (Binary)	33
3.11	16-Bit Data Divide (Binary)	37
4.	Application Program Example.....	42
4.1	File Handling (transfer)	42
4.2	File Handling (exchange).....	44
4.3	Code Conversion (packed BCD →unpacked BCD).....	47
4.4	Code Conversion (unpacked BCD →packed BCD).....	51
4.5	Code Conversion (BIN →BCD).....	55
4.6	Code Conversion (BCD →BIN).....	60
4.7	SGN Function	65
4.8	BCD 12-digit Floating Point Arithmetic Calculations.....	66
5.	Substitute Instruction	77
5.1	Swap Accumulator	77
5.2	Counter Bit Accumulator	78
5.3	Memory Set Bit	79
5.4	Memory Clear Bit	80
5.5	Memory Bit Reversal.....	81
6.	Program Usage Notes	82

1. Distinctive Features of 740 Family Instruction Set

The 740 Family instruction set offers the following distinctive features.

- (1) An efficient instruction set with many addressing modes allowing the effective use of user program area.
- (2) The same bit set/clear, bit test, and branch instructions can be applied for Accumulator, Memory and I/O area.
- (3) Multiple interrupts allow a variety of servicing of periodic or non-periodic events.
- (4) Powerful indexed addressing performs various byte and table-reference operations.
- (5) Decimal mode does not require any software correction for decimal operations.
- (6) Accumulator does not need to be used in operations using memories and/or I/Os.

2. Effective use of 740 Family MCU Distinctive Instructions

2.1 Memory-to-Memory Operations

(1) Addition (mnemonic ADC)

When X Modified Operation Mode Flag T is “1”, the ADC instruction adds the contents of M (X), Memory M and Carry Flag C and stores the results in M (X) and Carry Flag C. At this point, the contents of Accumulator A remain the same, but the status flags are changed. In this case, M (X) represents the contents of the memory at the address indicated by Index Register X.

Example:

CLC		(a)
SET		(b)
LDX	#ADDATA	(c)
ADC	\$10, X	(d)
CLT		(e)

Explanation:

- (a) Set Carry Flag C to “0”.
- (b) Set X Modified Operation Mode Flag T to “1”.
- (c) Load #ADDATA (example: 70H) to Index Register X.
- (d) Add the contents of the memory at address 70H, contents of address 80H (70H + 10H) and contents of Carry Flag C; store the results in address 70H and Carry Flag C.



- (e) Set X Modified Operation Mode Flag T to “0”.

For example, if the contents of address 70H are 53H and the contents of address 80H are 21H, the contents of address 70H will be 74H and Carry Flag C will be “0” after execution of the instructions in steps (a) to (e).

(2) Subtraction (mnemonic SBC)

When X Modified Operation Mode Flag T is “1”, the SBC instruction subtracts the value of Memory M and the complement of Carry Flag C from the contents of M (X), and stores the results in M (X) and Carry Flag C. At this point, the contents of Accumulator A remain the same, but the status flags are changed. In this case, M (X) represents the contents of the memory at the address indicated by Index Register X.

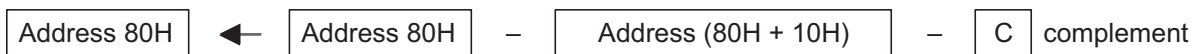
Example:

```

SEC                (a)
SET                (b)
LDX    #SBDATA    (c)
SBC    $10, X     (d)
CLT                (e)
    
```

Explanation:

- (a) Set Carry Flag C to “1”.
- (b) Set X Modified Operation Mode Flag T to “1”.
- (c) Load #SBDATA (example: \$80) to Index Register X.
- (d) Subtract the contents of address 90H (80H + 10H) and the complement of Carry Flag C from the contents of the memory at address 80H; store the results in address 80H and Carry Flag C.



- (e) Set X Modified Operation Mode Flag T to “0”.

For example, if the contents of address 80H are 53H and the contents of address 90H are 21H, the contents of address 80H will be 32H and Carry Flag C will be “1” after execution of the instructions in steps (a) to (e).

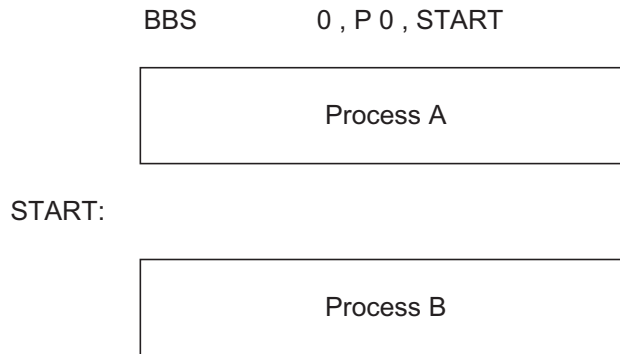
2.2 Bit Branch Instructions

(1) Branch On Bit Set (mnemonic BBS)

The BBS instruction tests the designated bit *i* of Accumulator A or Memory M. If the bit is “1”, the program branches to the specified address. The branch address is specified by a relative address.

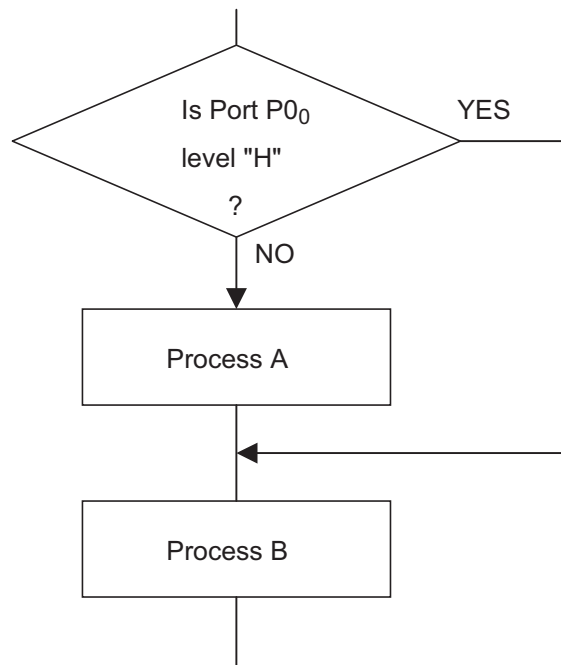
If the bit is “0”, the next instruction is executed.

Example:



Explanation:

If bit 0 of Port P0 is “1”, the program branches to START. If bit 0 of Port P0 is “0”, the program continues on the next instruction.



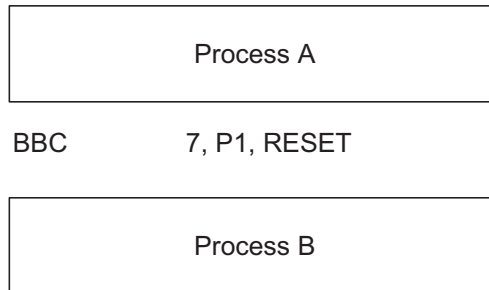
(2) Branch On Bit Clear (mnemonic BBC)

The BBC instruction tests the designated bit *i* of Accumulator A or Memory M. If the bit is “0”, the program branches to the specified address. The branch address is specified by a relative address.

If the bit is “1”, the next instruction is executed.

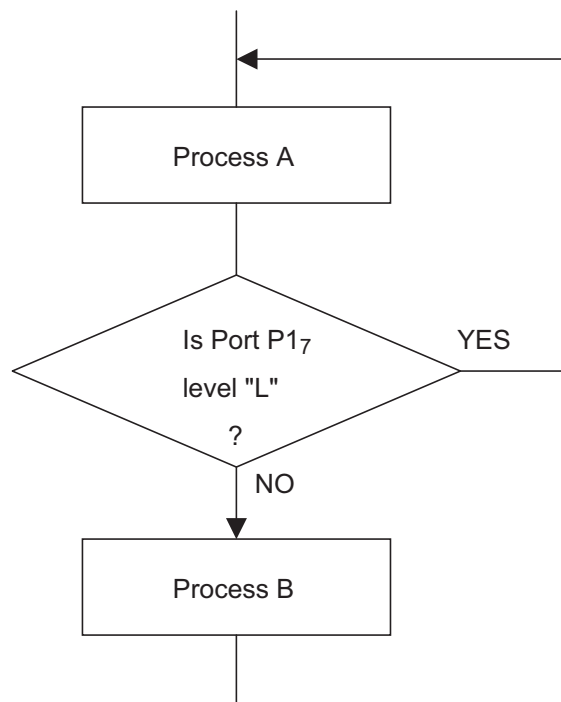
Example:

RESET:



Explanation:

If bit 7 of Port P1 is “0”, the program branches to RESET. If bit 7 of Port P1 is “1”, the program continues on the next instruction.



2.3 Bit Managing (Set/Reset)

(1) Set Bit (mnemonic SEB)

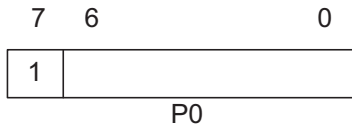
The SEB instruction sets the contents of the designated bit *i* of Accumulator A or Memory M to “1”.

Example:

SEB 7, P0

Explanation:

The contents of bit 7 of Port P0 are set to “1”.



For example, if the contents of Port P0 are 53H, the contents will be D3H after the instruction is executed.

(2) Clear Bit (mnemonic CLB)

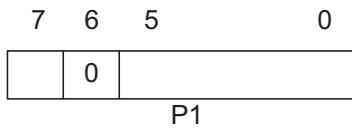
The CLB instruction sets the contents of the designated bit *i* of Accumulator A or Memory M to “0”.

Example:

CLB 6, P1

Explanation:

The contents of bit 6 of Port P1 are set to “0”.



For example, if the contents of Port P1 are 53H, the contents will be 13H after the instruction is executed.

2.4 Rotate Shift

(1) Rotate One Bit Left (mnemonic ROL)

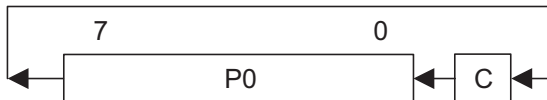
The ROL instruction puts the contents of Accumulator A or Memory M and Carry Flag C together as a 9-bit row and rotates the contents one bit to the left. Then, the contents of Carry Flag C are stored in bit 0 of Accumulator A or Memory M, and the contents of bit 7 of Accumulator A or Memory M are stored in Carry Flag C.

Example:

```
ROL P0
```

Explanation:

Port P0 is connected to Carry Flag C and their contents are rotated one bit to the left.



For example, if the contents of Port P0 are 53H and Carry Flag C is “1”, the contents of Port P0 will be A7H and Carry Flag C will be “0” after the instruction is executed.

(2) Arithmetic Shift Left (mnemonic ASL)

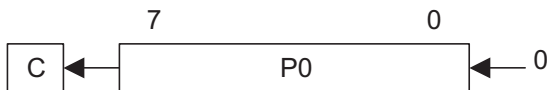
The ASL instruction shifts all bits of Accumulator A or Memory M one bit to the left. In this case, bit 0 of Accumulator A or Memory M will be “0”, and the contents of bit 7 of Accumulator A or Memory M are stored in Carry Flag C.

Example:

```
ASL P0
```

Explanation:

All Port P0 bits are shifted one bit to the left.



For example, if the contents of Port P0 are 53H and Carry Flag C is “1”, the contents of Port P0 will be A6H and Carry Flag C will be “0” after the instruction is executed.

(3) Rotate One Bit Right (mnemonic ROR)

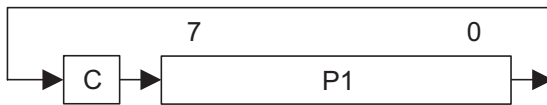
The ROR instruction puts the contents of Accumulator A or Memory M and Carry Flag C together as a 9-bit row and rotates the contents one bit to the right. Then, the contents of Carry Flag C are stored in bit 7 of Accumulator A or Memory M, and the contents of bit 0 of Accumulator A or Memory M are stored in Carry Flag C.

Example:

```
ROR P1
```

Explanation:

Port P1 and Carry Flag C are connected and their contents are rotated one bit to the right.



For example, if the contents of Port P1 are 53H and Carry Flag C is “1”, the contents of Port P1 will be 29H and Carry Flag C will remain as “1” after the instruction is executed.

(4) Logical Shift Right (mnemonic LSR)

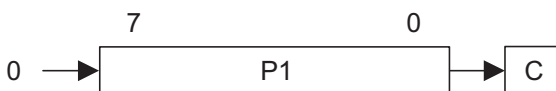
The LSR instruction shifts all bits of Accumulator A or Memory M one bit to the right. In this case, bit 7 of Accumulator A or Memory M will be “0”, and the contents of bit 0 of Accumulator A or Memory M are stored in Carry Flag C.

Example:

```
LSR P1
```

Explanation:

All bits of Port P1 are shifted one bit to the right.



For example, if the contents of Port P1 are 53H and Carry Flag C is “1”, the contents of Port P1 will be 29H and Carry Flag C will remain as “1” after the instruction is executed.

(5) Rotate Right of Four Bits (mnemonic RRF)

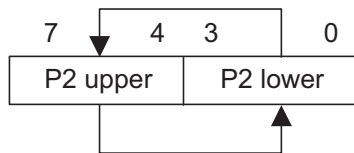
The RRF instruction rotates the contents of Memory M four bits to the right. As a result, the contents of the upper-order and lower-order four bits of Memory M are reversed, but the order of the respective four bits does not change.

Example:

RRF P2

Explanation:

The contents of the upper-order and lower-order four bits of Port P2 are reversed.



For example, if the contents of Port P2 are 53H, the contents will be 35H after the instruction is executed.

3. Basic Processing Program Example

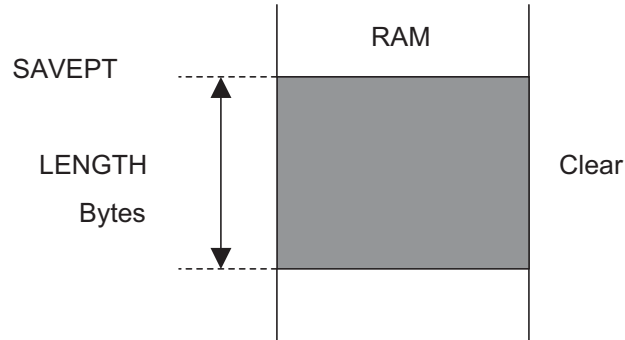
3.1 RAM Clear

(1) Description

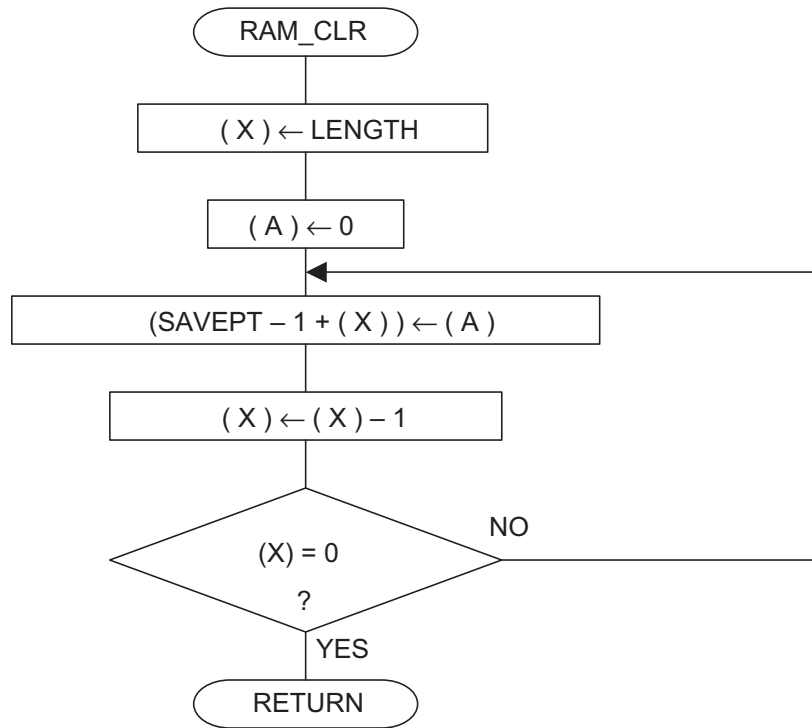
This program sets the area and clears the RAM.

(2) Explanation

The program clears LENGTH Bytes of RAM from RAM address SAVEPT.



(3) Flowchart



(4) Program List

```

;*****
;
;       RAM clear routine
;
;*****
;
RAM_CLR:
        LDX        #LENGTH ;RAM length
        LDA        #$00
RAMCL1:
        STA        SAVEPT-1,X ;Clear from SAVEPT
        DEX        ; -to SAVEPT+LENGTH-1
        BNE        RAMCL1 ;Clear end ?
        RTS        ;Yes
  
```

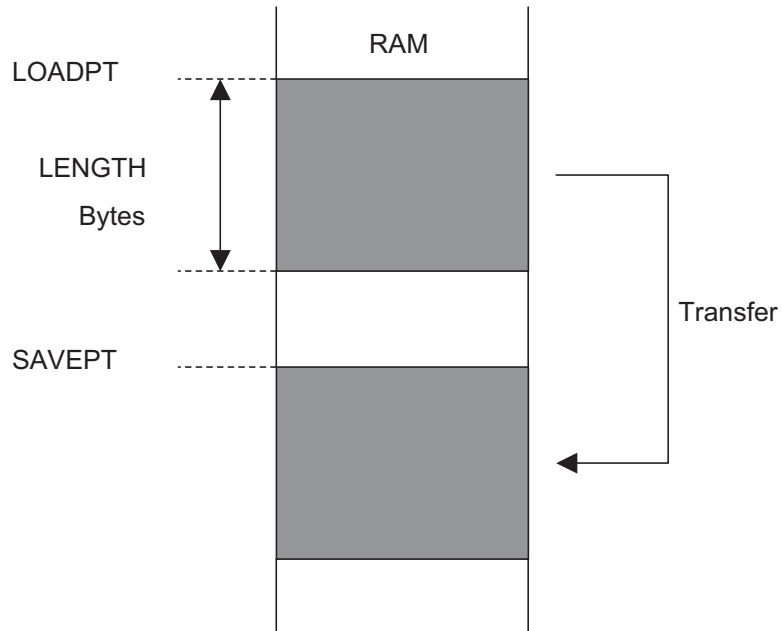
3.2 Data Transfer (RAM)

(1) Description

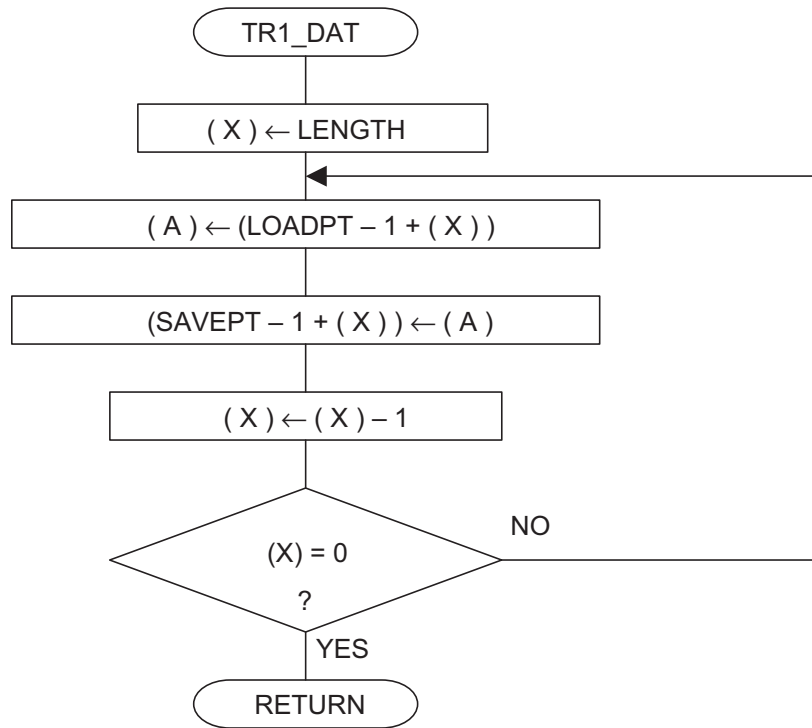
Data is transferred within the RAM area.

(2) Explanation

LENGTH Bytes of data are transferred from RAM address LOADPT to addresses starting at SAVEPT.



(3) Flowchart



(4) Program List

```

;*****
;
;       RAM data transfer routine
;
;*****
;
TR1_DAT:
LDX     #LENGTH      ;RAM length
TR1_01: LDA     LOADPT-1,X  ;Transfer data from LOADPT
        STA     SAVEPT-1,X  ; -to SAVEPT
        DEX
        BNE     TR1_01      ;Transfer end ?
        RTS          ;Yes
  
```

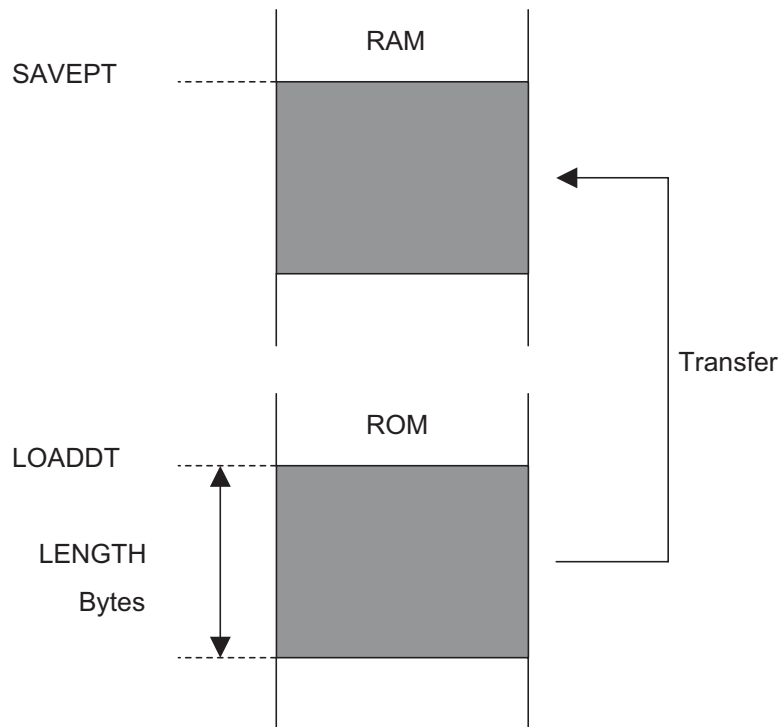

3.3 Data Transfer (ROM address fixed)

(1) Description

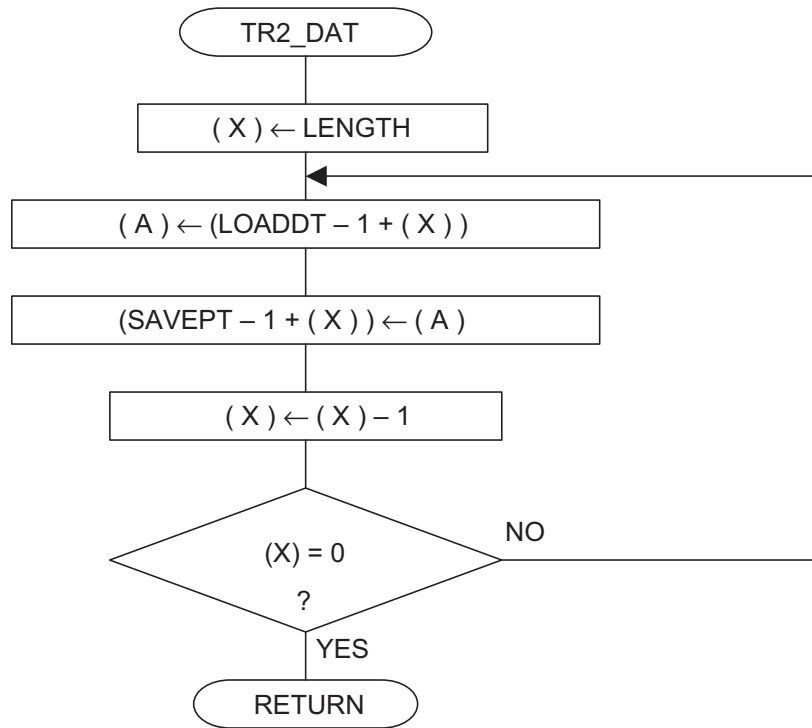
Data (address fixed) is transferred from the ROM area.

(2) Explanation

LENGTH Bytes of data are transferred from ROM address LOADDT to continuous RAM addresses, starting at SAVEPT.



(3) Flowchart



(4) Program List

```

;*****
;
;       ROM data transfer routine(address fixed)
;
;*****
;
TR2_DAT:
LDX   #LENGTH           ;ROM length
TR2_01: LDA   LOADDT-1,X ;Transfer data from LOADDT
      STA   SAVEPT-1,X  ; -to SAVEPT
      DEX
      BNE  TR2_01       ;Transfer end ?
      RTS                ;Yes
  
```

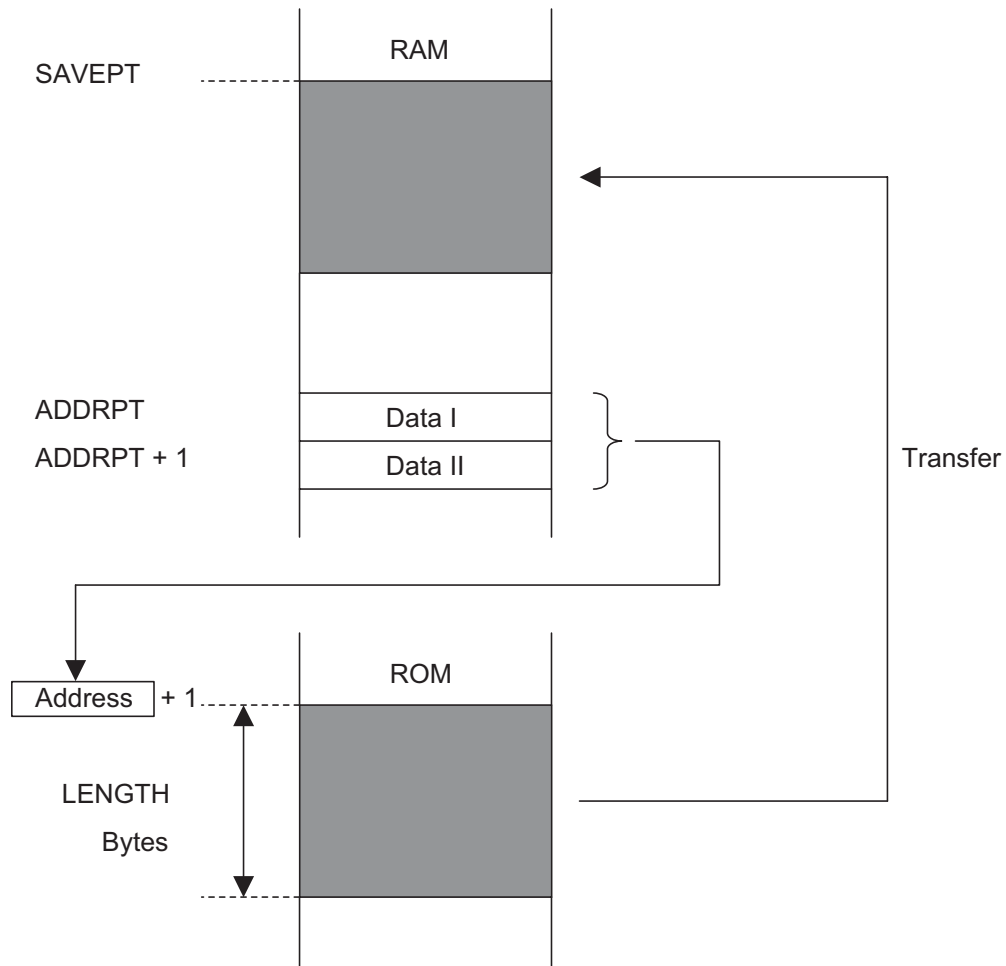
3.4 Data Transfer (ROM address variable)

(1) Description

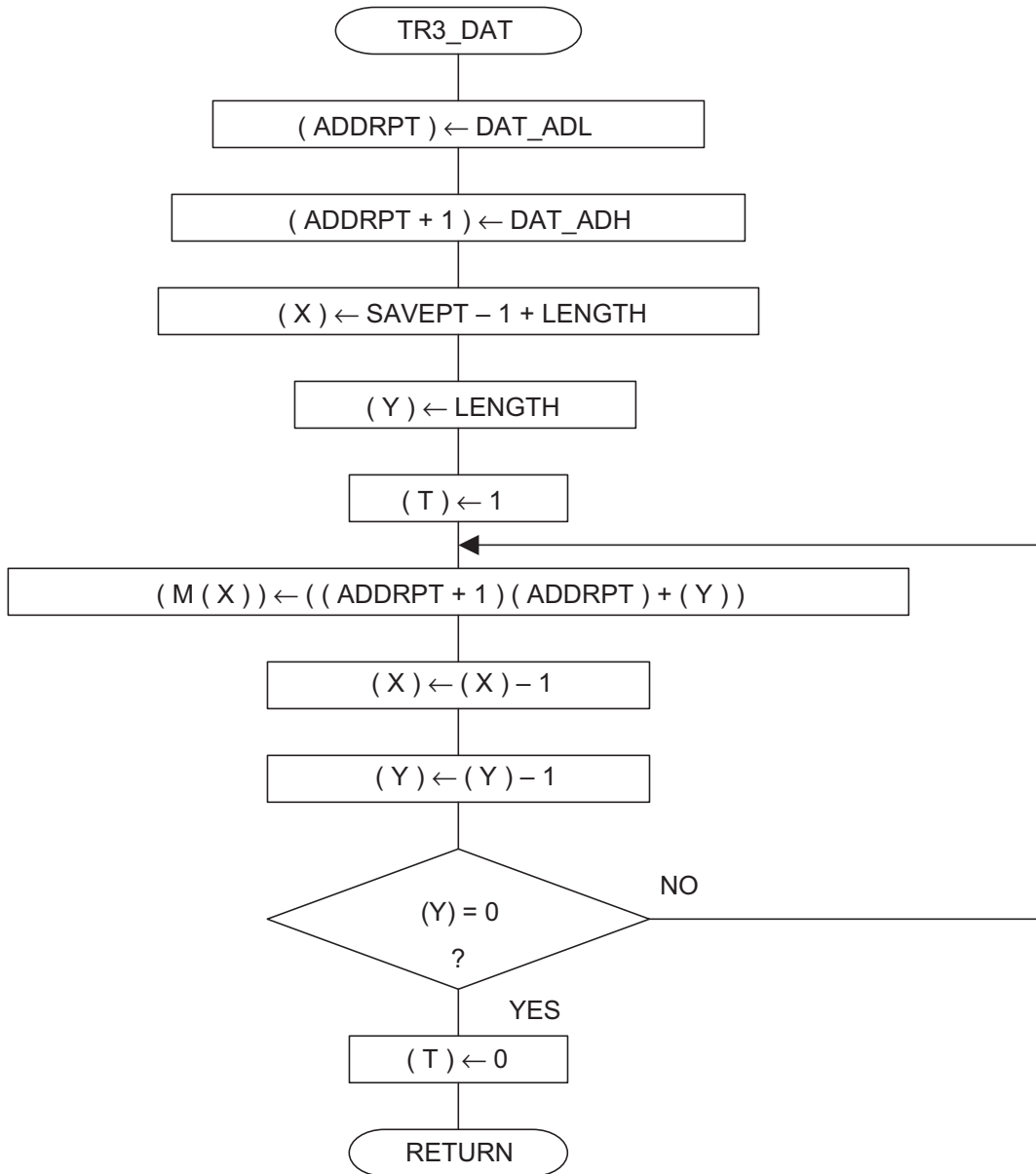
Data (address variable) is transferred from the ROM area.

(2) Explanation

LENGTH Bytes of data are transferred to continuous RAM addresses, starting at SAVEPT, from the ROM address +1 specified in the contents of RAM address ADDRPT +1 and ADDRPT.



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;       ROM data transfer routine(address float)
;
;*****
;
TR3_DAT:
        LDM        #DAT_ADL,ADDRPT
        LDM        #DAT_ADH,ADDRPT+1
;-----
        LDX        #SAVEPT-1+LENGTH
        LDY        #LENGTH           ;ROM length
        SET        ;Transfer data from
TR3_01: LDA        (ADDRPT),Y        ; -(ADDRPT+1)(ADDRPT)+1
        DEX        ; -to SAVEPT
        DEY        ;
        BNE        TR3_01           ;Transfer end ?
        CLT        ;Yes
        RTS

```

3.5 Data Sort

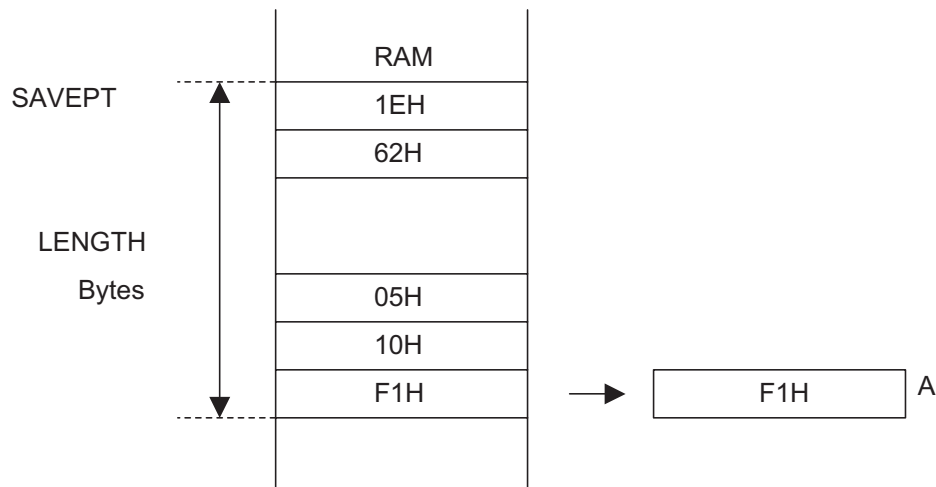
(1) Description

The data in the RAM area is sorted in descending order.

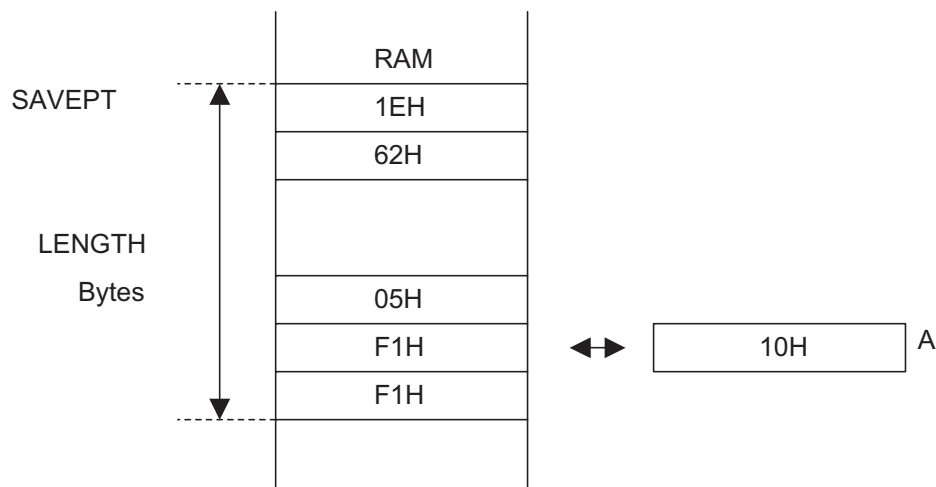
(2) Explanation

LENGTH bytes of data are sorted in descending order from RAM address SAVEPT.

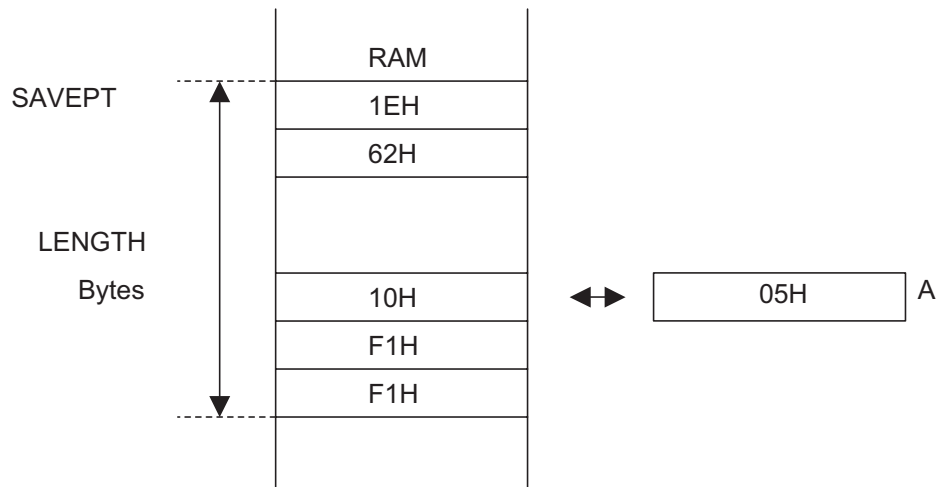
(a) First, the memory contents of the highest address to be sorted are stored in Accumulator A.



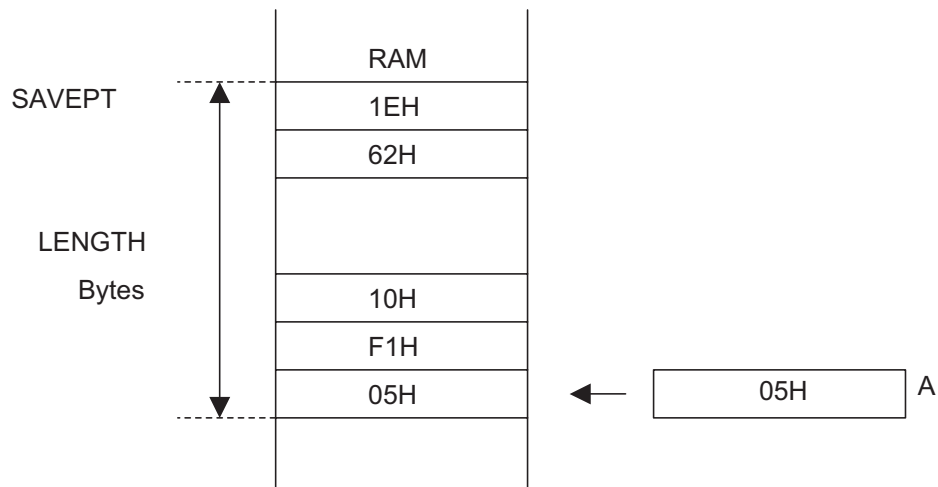
(b) Next, the memory contents of the next lower address are compared with the contents of Accumulator A. At this time, if the contents of Accumulator A are equal to or larger than the contents of the lower address, the contents of the memory and the Accumulator A are switched.



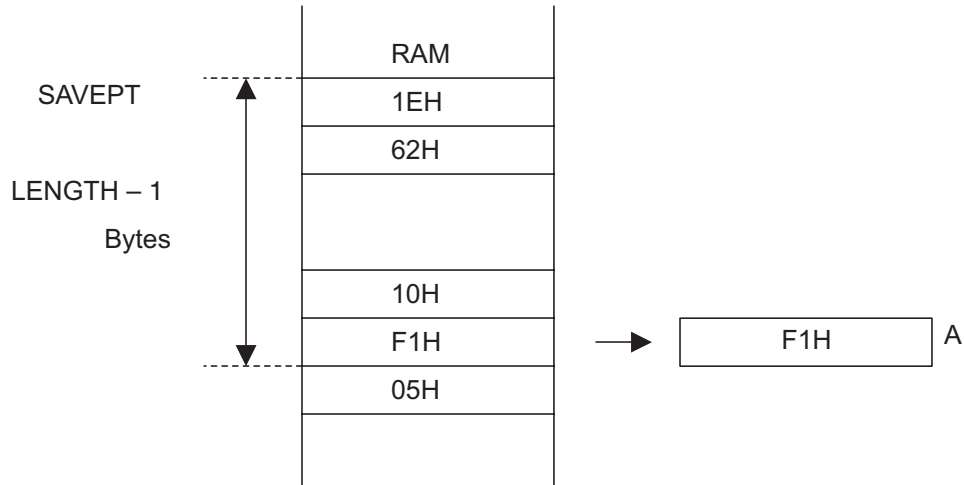
- (c) The contents of the next lower address are compared with the contents of Accumulator A. At this time, if the contents of Accumulator A are equal to or larger than the contents of the memory, the contents of the memory and the Accumulator A are switched again.



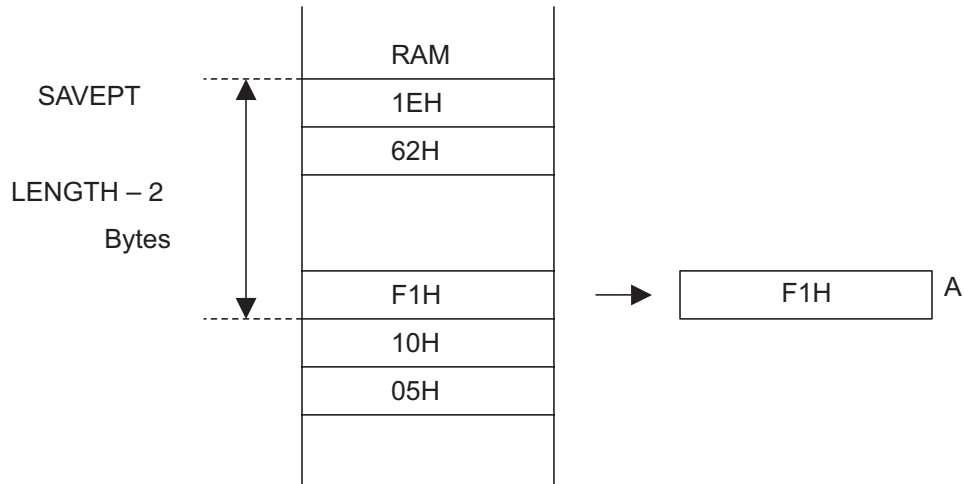
- (d) This process is repeated until it reaches the lowest address and the contents of its memory are sorted, after which the lowest value will be stored in Accumulator A. The contents of this Accumulator A will be sent to the highest address in the memory.



- (e) Steps (a) through (d) are executed on the sorted area of which the highest address has been decreased, (LENGTH bytes - 1 byte) from SAVEPT.

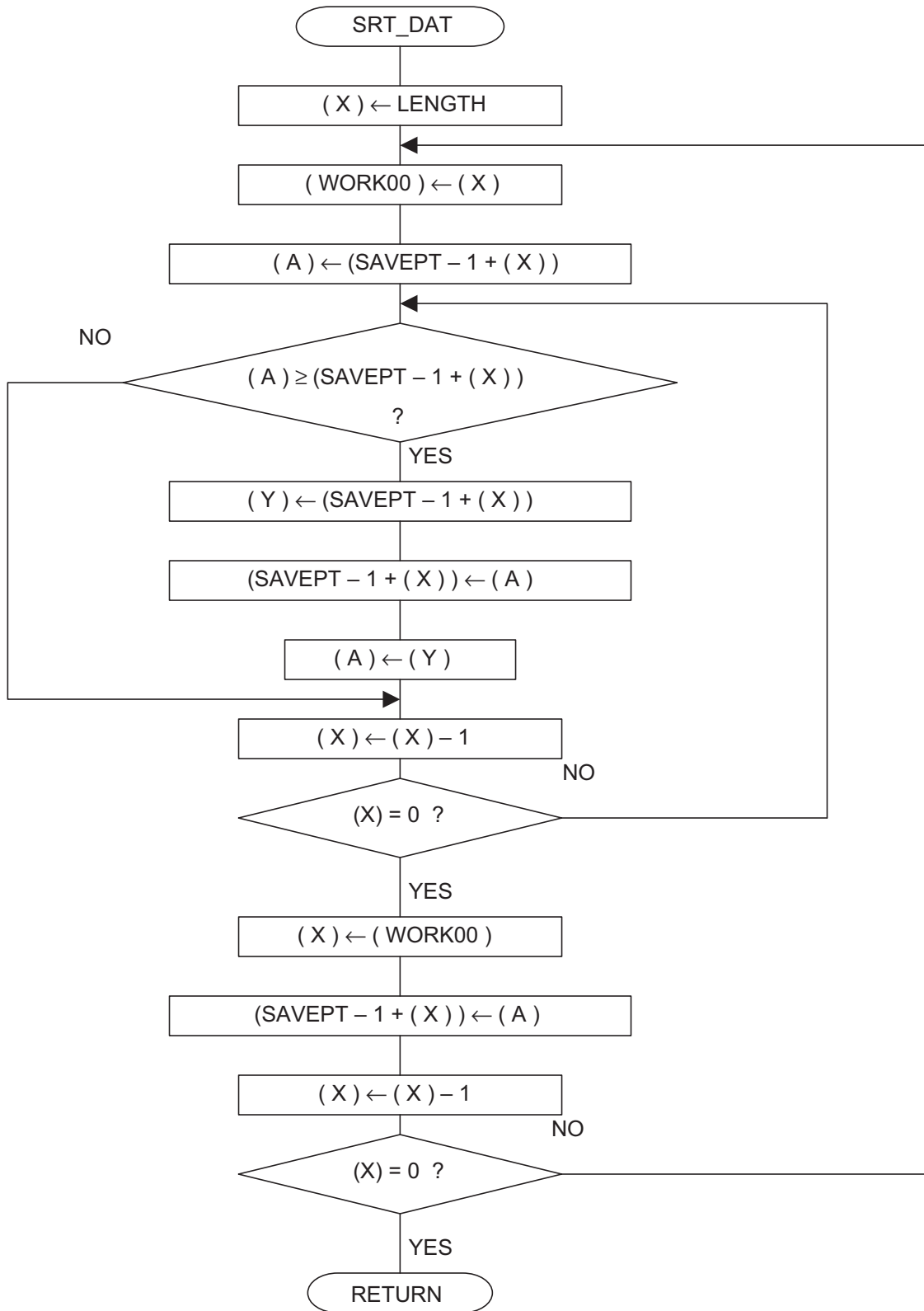


- (f) Again, steps (a) through (d) are executed on the sorted area of which the highest address has been decreased, (LENGTH bytes - 2 bytes) from SAVEPT.



- (g) In this manner, steps (a) through (d) are executed until the order of the contents is sorted into descending order, decreasing the highest address until it reaches the lowest address. In addition, in steps (b) through (c), if the contents are switched when the contents of Accumulator A are smaller than those of the memory, the contents can be sorted into ascending order.

(3) Flowchart



(4) Program List

```

;*****
;
;           Sort routine
;
;*****
;
SRT_DAT:
    LDX     #LENGTH           ;Data length
SRT_01:   STX     WORK00
    LDA     SAVEPT-1,X       ;SAVEPT<-->SAVEPT-1+WORK00
SRT_02:   CMP     SAVEPT-1,X   ;If use(BCS)
    BCC     SRT_03           ; -then negative
    LDY     SAVEPT-1,X
    STA     SAVEPT-1,X
    TYA
SRT_03:   DEX
    BNE     SRT_02
    LDX     WORK00
    STA     SAVEPT-1,X       ;Minimum data set
    DEX
    BNE     SRT_01           ;Next area
    RTS
    BNE     SRT_01           ;Sort end ?
    RTS
    ;Yes

```

3.6 16-Bit Data Add (Binary)

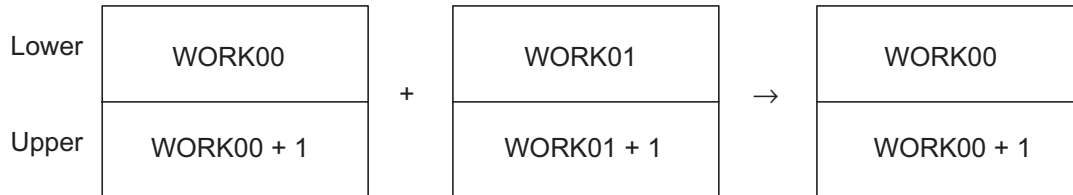
(1) Description

Addition of 16-bit binary data is performed.

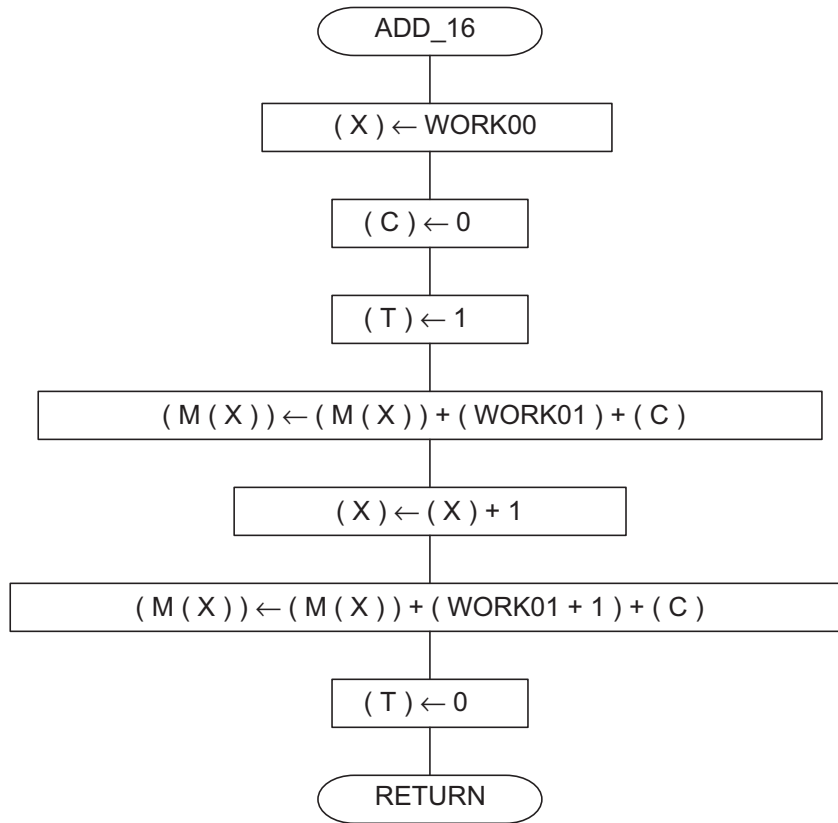
(2) Explanation

The contents of WORK00 +1 and WORK00 are added to the contents of WORK01 +1 and WORK01, respectively; and the results are stored to WORK00 +1 and WORK00, respectively.

When X Modified Operation Mode Flag T is set to “1”, the data is added without destroying the contents of Accumulator A.



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;    16 bits BIN. data addition routine
;
;*****
;
ADD_16:
    LDX    #WORK00
    CLC                    ;C flag clear
    SET    T                ;T flag set
    ADC    WORK01
    INX                    ;(WORK00+1)(WORK00)+
    ADC    WORK01+1        ;(WORK01+1)(WORK01)
    CLT                    ;T flag clear
    RTS
  
```

3.7 16-Bit Data Subtract (Binary)

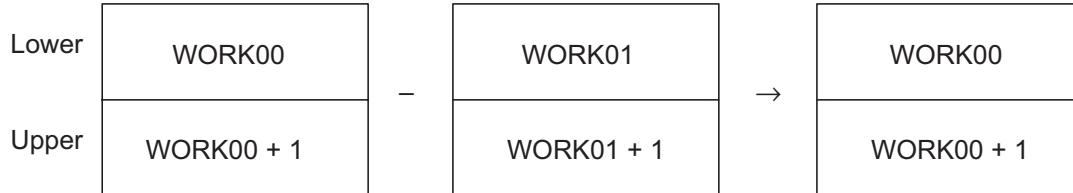
(1) Description

Subtraction of 16-bit binary data is performed.

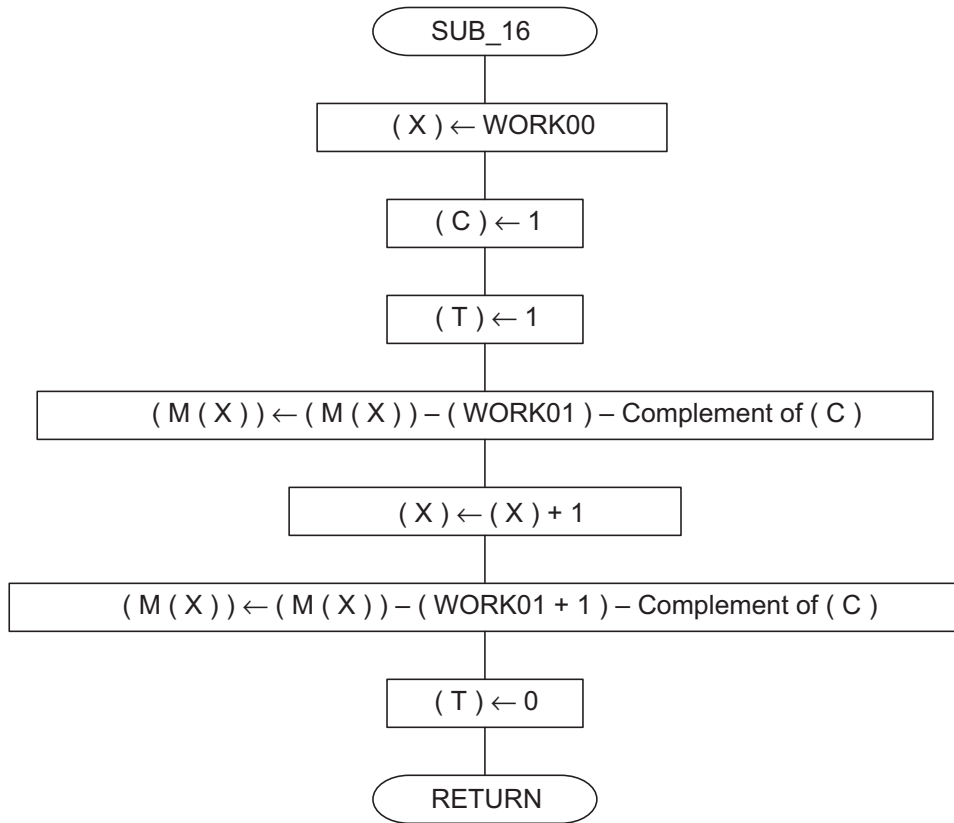
(2) Explanation

The contents of WORK01 +1 and WORK01 are subtracted from the contents of WORK00 +1 and WORK00, respectively, and the results are stored to WORK00 +1 and WORK00, respectively.

When X Modified Operation Mode Flag T is set to “1”, the data is subtracted without destroying the contents of Accumulator A.



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;      16 bits BIN. data subtraction routine
;
;*****
;
SUB_16:
    LDX    #WORK00
    SEC                      ;C flag set
    SET                      ;T flag set
    SBC    WORK01
    INX                      ;(WORK00+1)(WORK00)-SBC
    WORK01+1                  ;(WORK01+1)(WORK01)
    CLT                      ;T flag clear
    RTS
  
```

3.8 16-Bit Data Add (BCD)

(1) Description

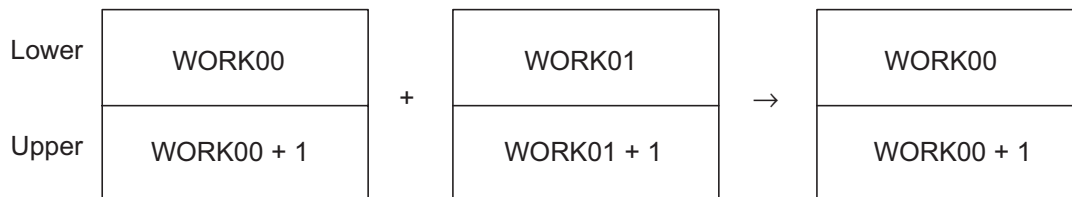
Addition of 16-bit BCD data is performed.

(2) Explanation

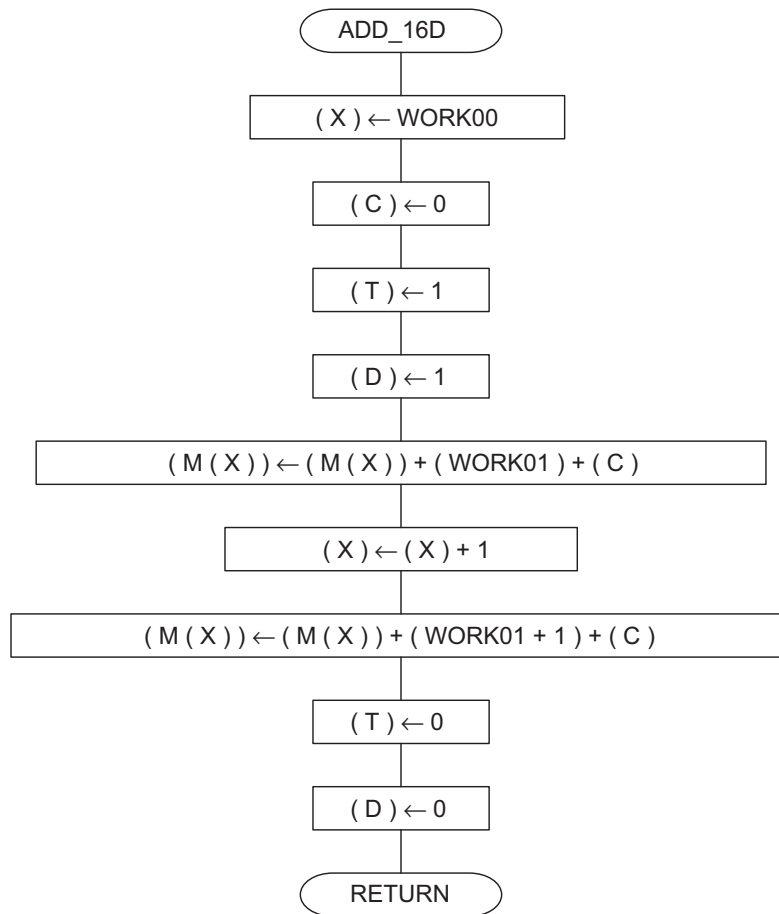
The contents of WORK00 +1 and WORK00 are added to the contents of WORK01 +1 and WORK01, respectively, and the results are stored to WORK00 +1 and WORK00, respectively.

By setting Decimal Mode Flag D to “1”, the ADC instruction can use decimal arithmetic. However, this will delay determination of Carry Flag C, so that make sure the SEC, CLC, and CLD instructions are not executed right after the ADC instruction.

When X Modified Operation Mode Flag T is set to “1”, the data is added without destroying the contents of Accumulator A.



(3) Flowchart



Note: M(X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;      16 bits BCD data addition routine
;
;*****
ADD_16D:
    LDX    #WORK00
    CLC                    ;C flag reset
    SET    ;T flag set
    SED    ;Decimal mode set
    ADC    WORK01
    INX    ;(WORK00+1)(WORK00)+
    ADC    WORK01+1        ;(WORK01+1)(WORK01)
    CLT    ;T flag reset
    CLD    ;Decimal mode clear
    RTS
  
```


3.9 16-Bit Subtract (BCD)

(1) Description

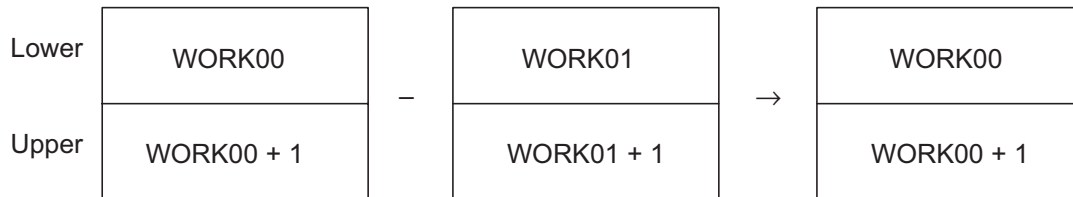
Subtraction of 16-bit BCD data is performed.

(2) Explanation

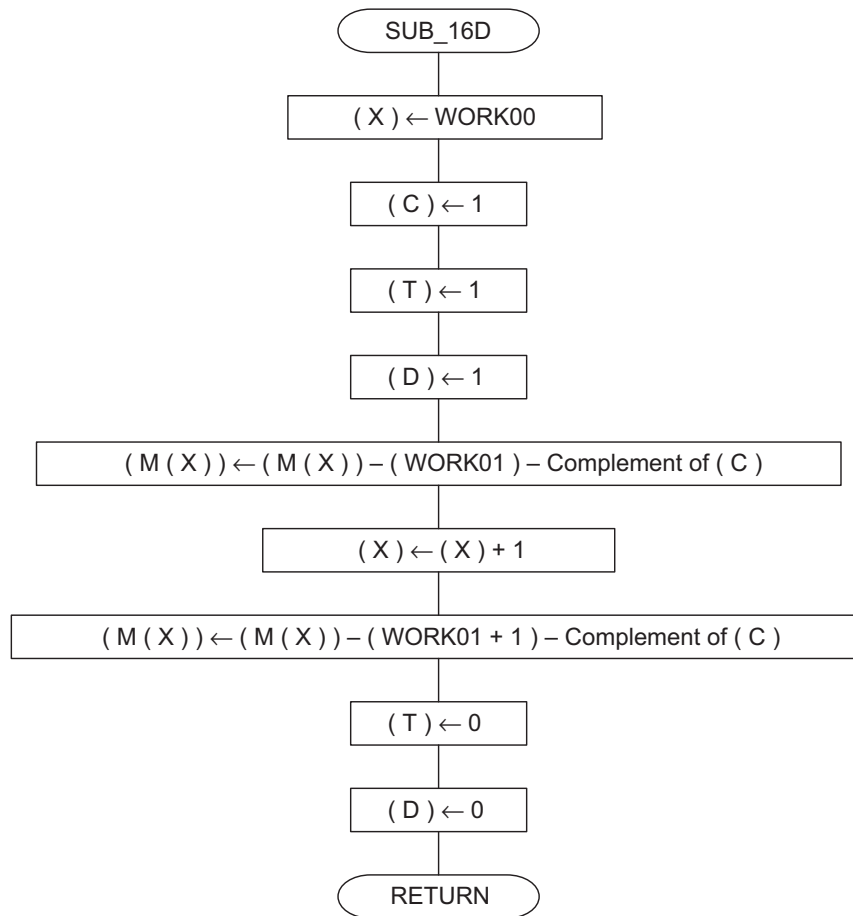
The contents of WORK01 +1 and WORK01 are subtracted from the contents of WORK00 +1 and WORK00, respectively, and the results are stored to WORK00 +1 and WORK00, respectively.

By setting Decimal Mode Flag D to “1”, the SBC instruction can use decimal arithmetic. However, this will delay determination of Carry Flag C, so that make sure the SEC, CLC, and CLD instructions are not executed right after the SBC instruction.

When X Modified Operation Mode Flag T is set to “1”, the data is subtracted without destroying the contents of Accumulator A.



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;      16 bits BCD data subtraction routine
;
;*****
SUB_16D:
    LDX    #WORK00
    SEC                    ;C flag set
    SET                    ;T flag set
    SED                    ;Decimal mode set
    SBC    WORK01
    INX                    ; (WORK00+1)(WORK00)-
    SBC    WORK01+1       ; (WORK01+1)(WORK01)
    CLT                    ;T flag reset
    CLD                    ;Decimal mode reset
    RTS
  
```

3.10 16-Bit Data Multiply (Binary)

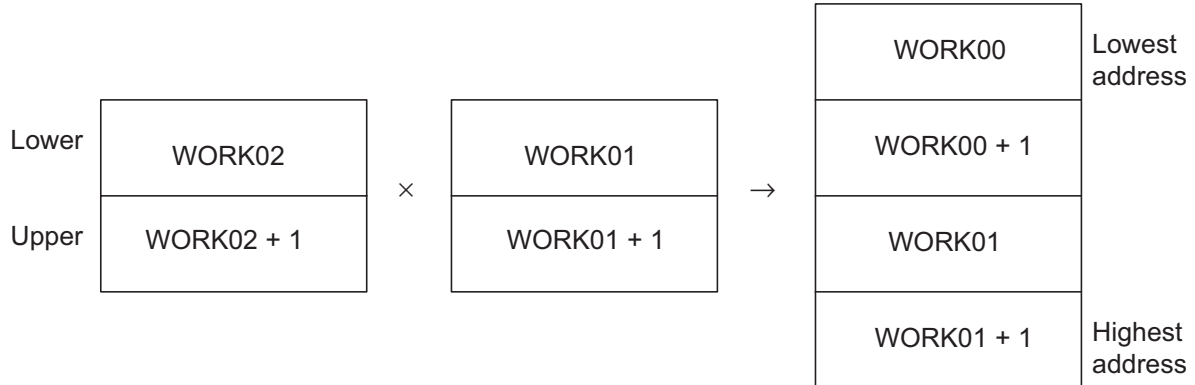
(1) Description

Multiplication of 16-bit binary data is performed.

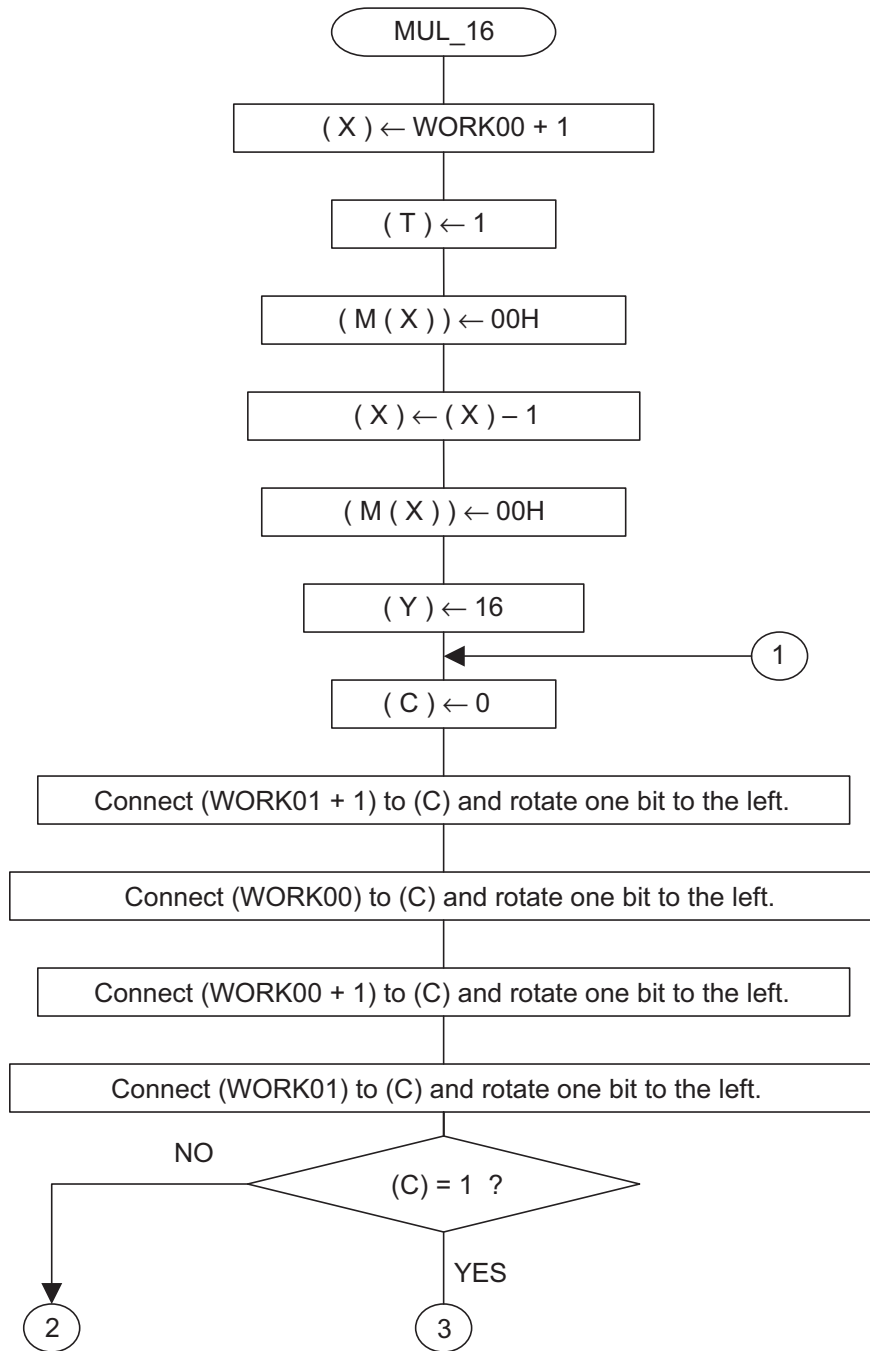
(2) Explanation

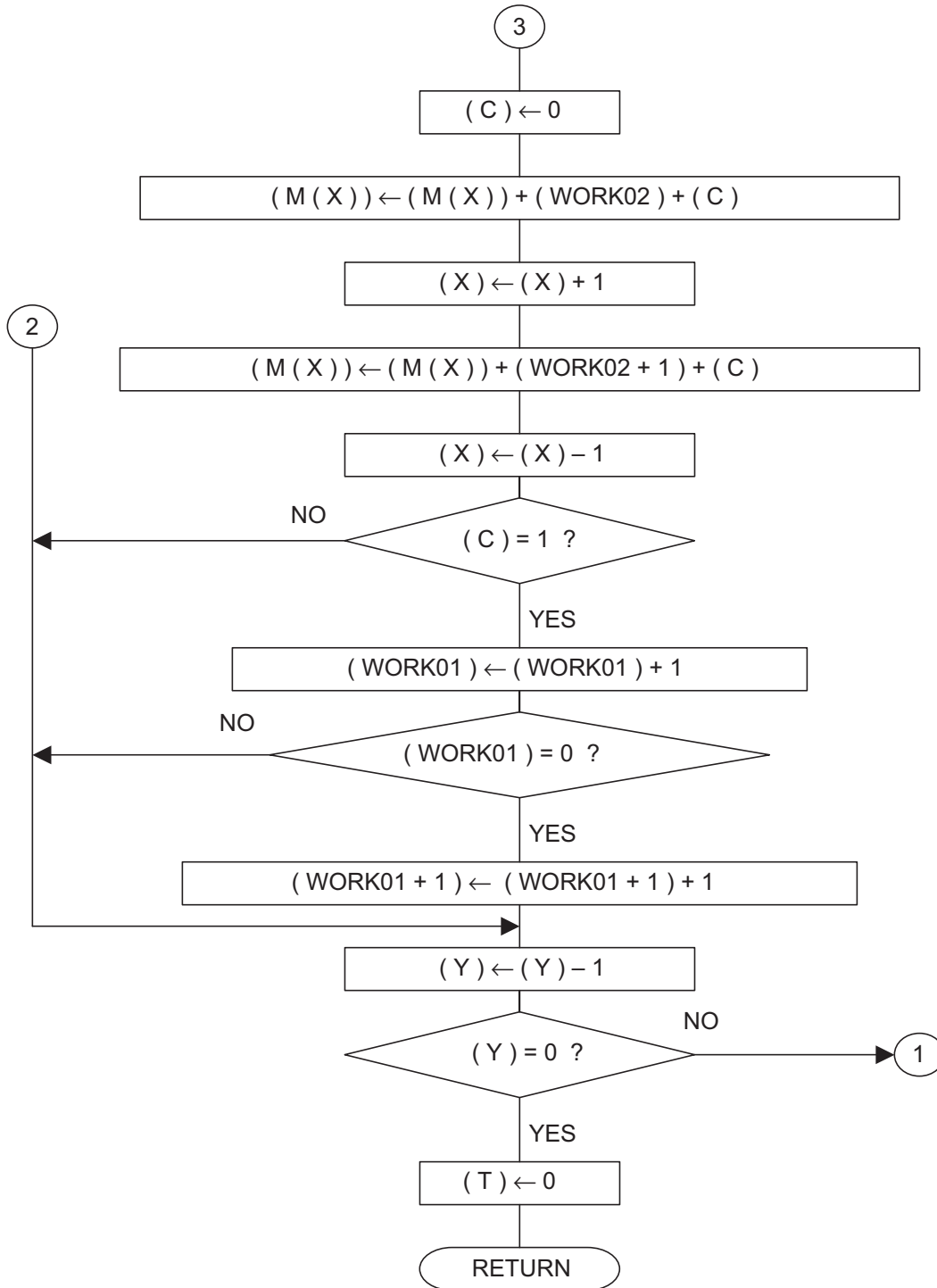
The contents of WORK02 +1 and WORK02 are multiplied by the contents of WORK01 +1 and WORK01, respectively, and the results are stored to WORK01 +1, WORK01, WORK00 +1 and WORK00.

When X Modified Operation Mode Flag T is set to “1”, the data is multiplied without destroying the contents of Accumulator A.



(3) Flowchart





Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;      16 bits BIN. data multiplication routine
;
;*****
;
MUL_16:
    LDX      #WORK00+1      ;Product L addr. set
    SET                      ;T flag set
    LDA      #$00          ;Clear product L
    DEX
    LDA      #$00
    LDY      #16          ;Bit counter set
;-----
MUL_01:  CLC
        ROL      WORK00      ;Rotate product L
        ROL      WORK00+1
        ROL      WORK01      ;Rotate product H
        ROL      WORK01+1
        BCC      MUL_02      ;C flag 1 ?
        CLC                  ;Yes
        ADC      WORK02      ;Multiplicand + product L
        INX
        ADC      WORK02+1
        DEX
        BCC      MUL_02      ;Over flow ?
        INC      WORK01      ;Yes
        BNE      MUL_02      ;Over flow ?
        INC      WORK01+1    ;Yes
;-----
MUL_02:  DEY
        BNE      MUL_01      ;Multiple end ?
        CLT                  ;Yes
        RTS

```

3.11 16-Bit Data Divide (Binary)

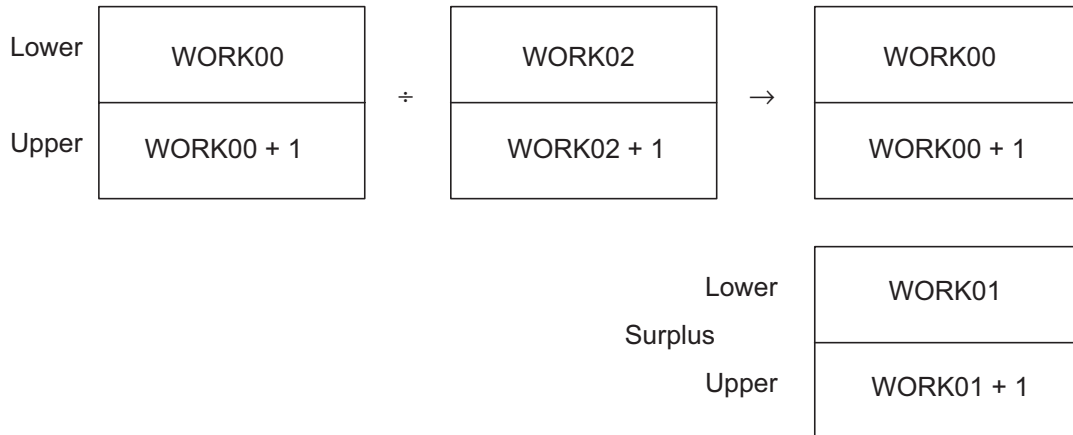
(1) Description

Division of 16-bit binary data is performed.

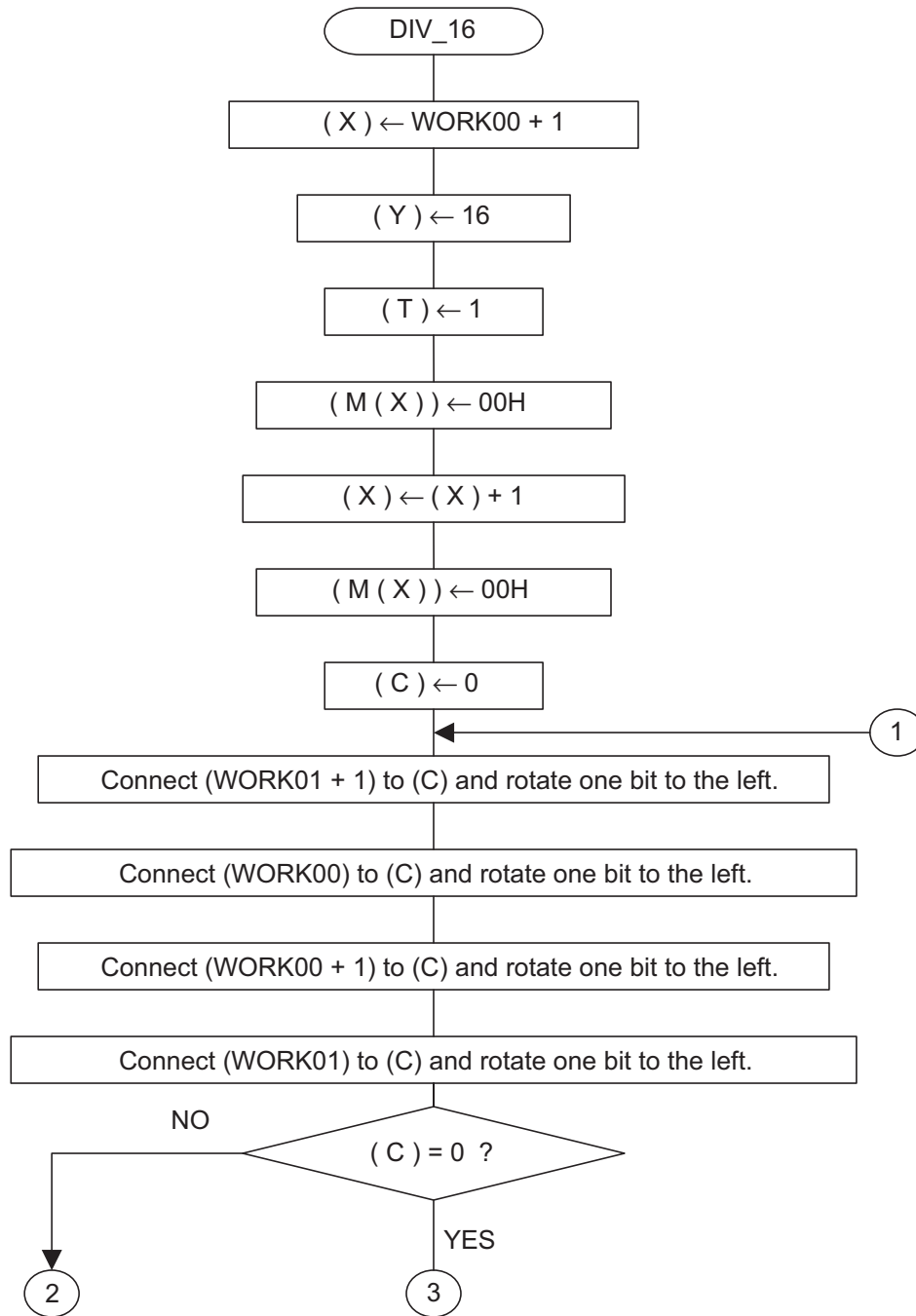
(2) Explanation

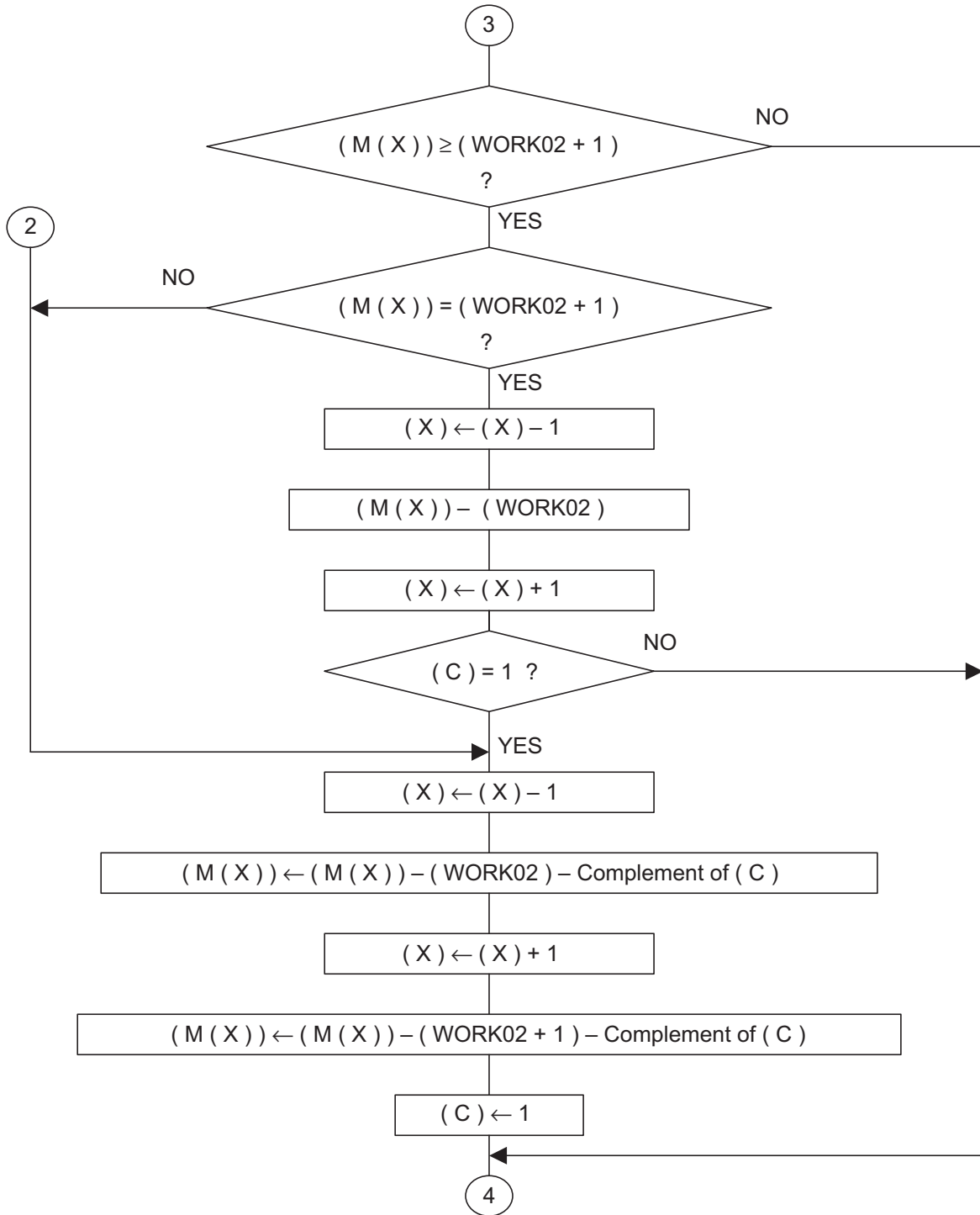
The contents of WORK00 +1 and WORK00 are divided by the contents of WORK02 +1 and WORK02. The quotients are stored to WORK00 +1, and WORK00; and the surpluses are stored to WORK01 +1 and WORK01.

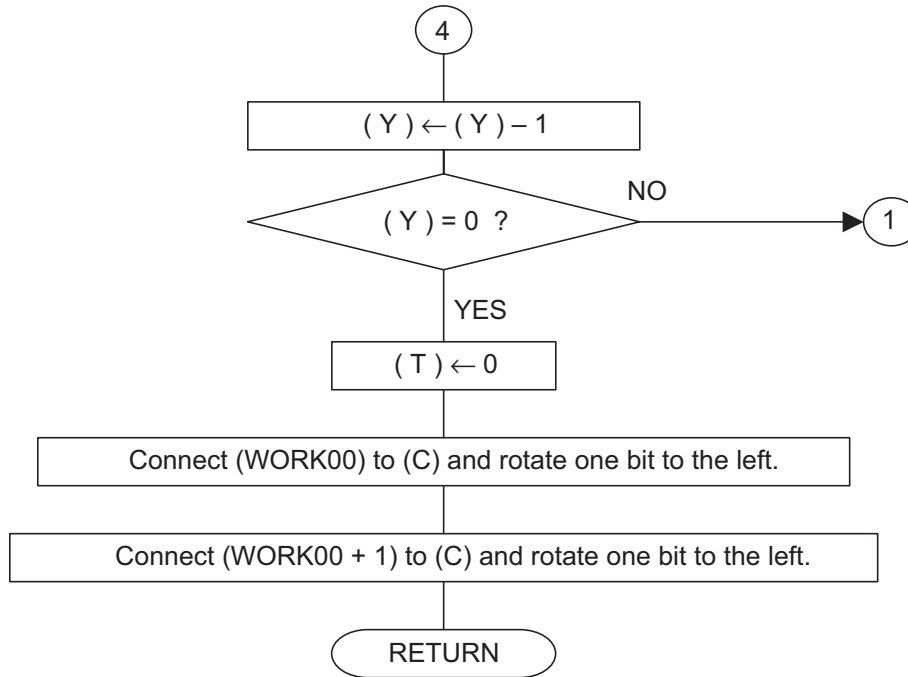
When X Modified Operation Mode Flag T is set to “1”, the data is divided without destroying the contents of Accumulator A.



(3) Flowchart







Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;       16 bits BIN. data division routine
;
;*****
;
DIV_16:
        LDX      #WORK01      ;Surplus addr. set
        LDY      #16         ;Bit counter set
        SET     ;T flag set
        LDA      #$00        ;Clear surplus
        INX
        LDA      #$00
        CLC
DIV_01:  ROL     WORK00        ;Rotate quotient
        ROL     WORK00+1
        ROL     WORK01        ;Rotate surplus
        ROL     WORK01+1
        BCS     DIV_02        ;C flag 1 ?
;-----
        CMP     WORK02+1      ;No
        BCC     DIV_03        ;Cannot divide ?
        BNE     DIV_02        ;No
        DEX
        CMP     WORK02
        INX
        BCC     DIV_03        ;Cannot divide ?
;-----
DIV_02:  DEX                ;No
        SBC     WORK02        ;Surplus - divisor
        INX
        SBC     WORK02+1
        SEC
DIV_03:  DEY
        BNE     DIV_01        ;Divide end ?
;-----
        CLT                ;Yes
        ROL     WORK00        ;Rotate quotient
        ROL     WORK00+1
        RTS

```

4. Application Program Example

4.1 File Handling (transfer)

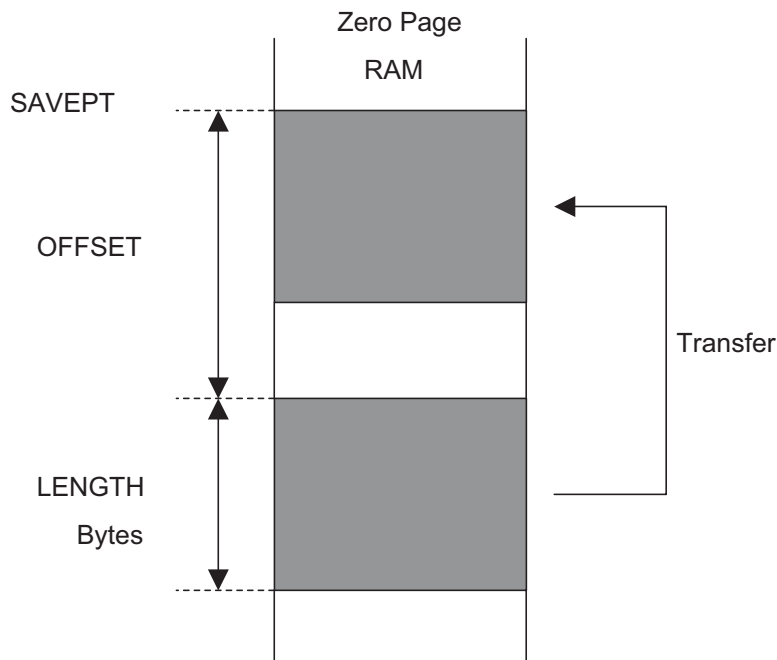
(1) Description

This operation recognizes a part of the zero page RAM as the file memory and executes the data transfer process from one location to another.

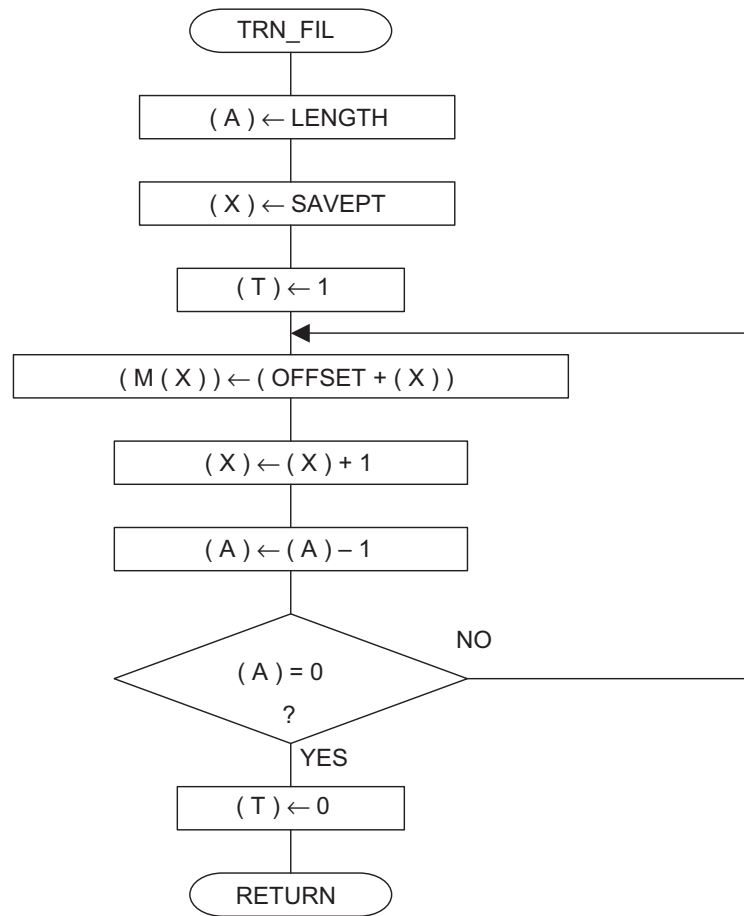
(2) Explanation

LENGTH bytes of file memory data are transferred from the zero page RAM address SAVEPT + OFFSET to continuous zero page RAM addresses starting at SAVEPT.

X Modified Operation Mode Flag T is set, and then the data is transferred between memories. The pointer is set to single pointer + OFFSET, not double pointer (source/target).



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;       File handling (transfer)
;
;*****
TRN_FIL:
    LDA    #LENGTH        ;File length
    LDX    #SAVEPT
    SET    T              ;T flag set

TRN_01:
    LDA    OFFSET,X       ;Transfer data from
    INX                    ; -SAVEPT+OFFSET
    DEC    A              ; -to SAVEPT
    BNE    TRN_01        ;Transfer end ?
    CLT                    ;Yes
    RTS
  
```

4.2 File Handling (exchange)

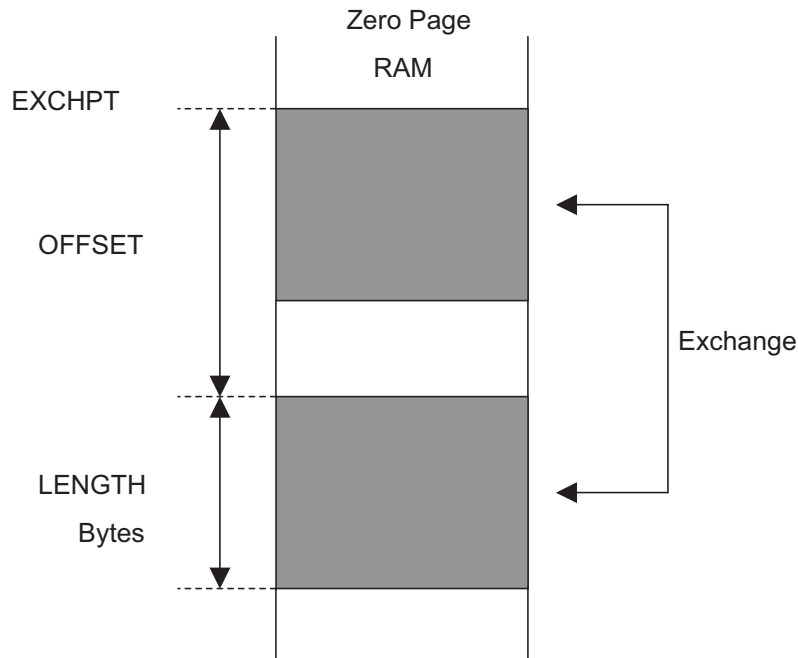
(1) Description

This operation recognizes a part of the zero page RAM as the file memory and executes the data exchange process from one location to another.

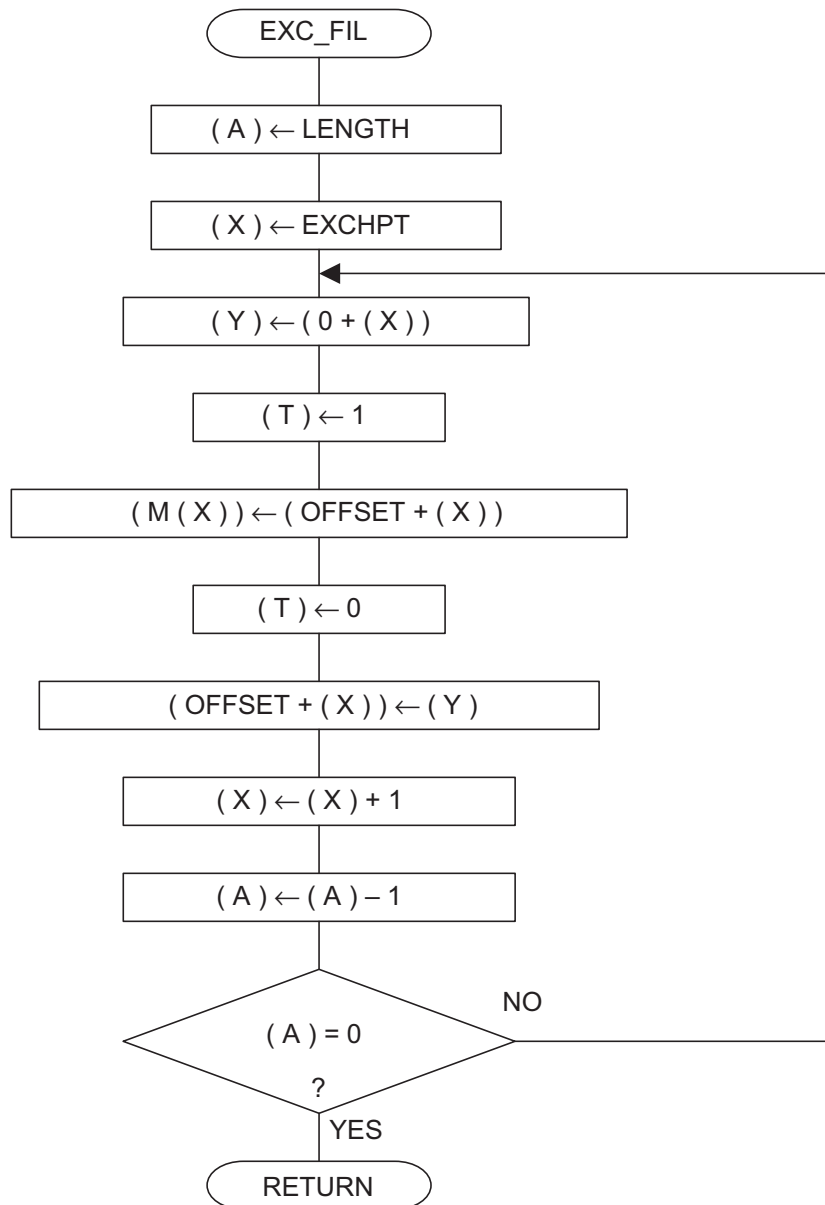
(2) Explanation

LENGTH bytes of file memory data from the zero page RAM address EXCHPT + OFFSET are exchanged with the data from zero page RAM address EXCHPT.

X Modified Operation Mode Flag T is set, and then the data is transferred between memories. The pointer is set to single pointer + OFFSET, not double pointer (source/target).



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;           File handling (exchange)
;
;*****
;
EXC_FIL:
    LDA     #LENGTH           ;File length
    LDX     #EXCHPT
EXC_01:
    LDY     0,X               ;Exchange data of
    SET     ; -EXCHPT+OFFSET
    LDA     OFFSET,X         ; -with EXCHPT
    CLT
    STY     OFFSET,X
    INX
    DEC     A
    BNE     EXC_01           ;Exchange end ?
    RTS                     ;Yes

```


4.3 Code Conversion (packed BCD → unpacked BCD)

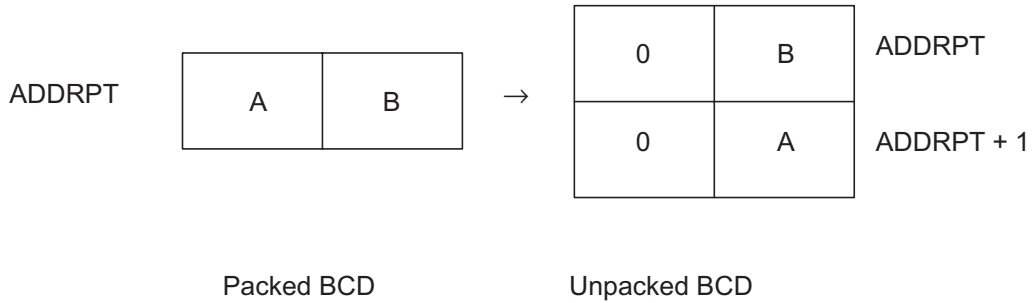
(1) Description

Packed BCD data is converted to unpacked BCD data.

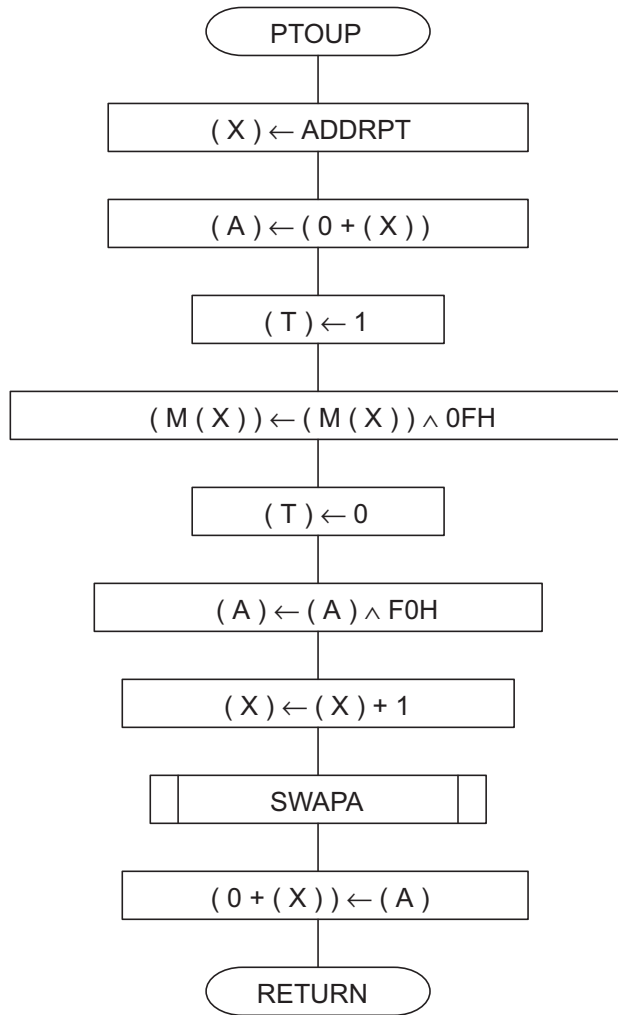
(2) Explanation

The packed BCD data at zero page RAM address ADDRPT is converted to the unpacked BCD data and stored at ADDRPT and ADDRPT + 1.

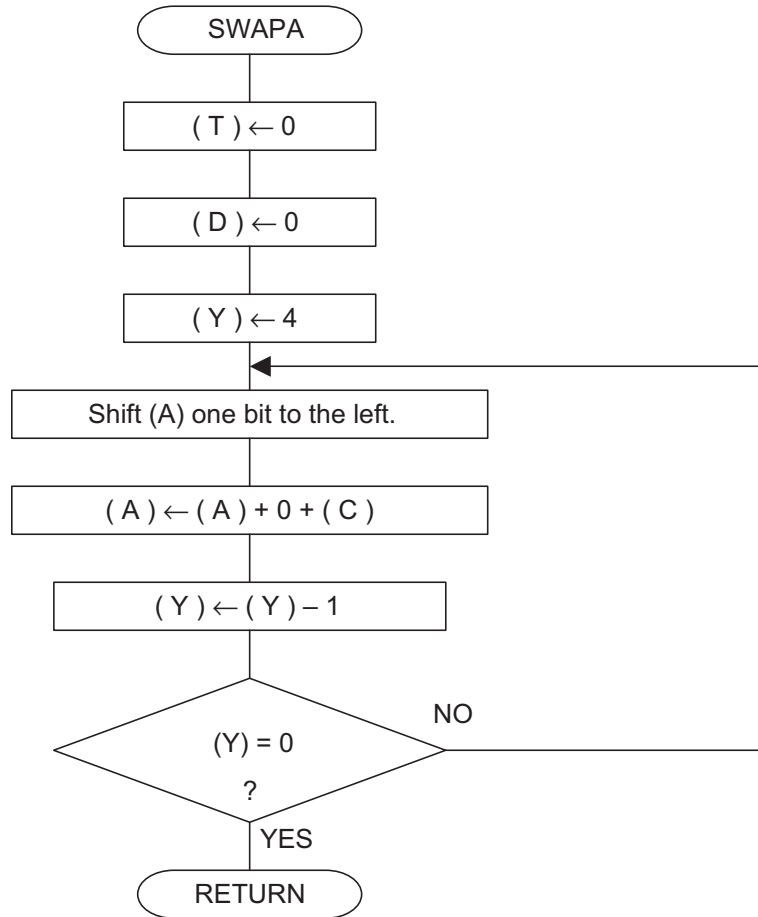
A packed BCD consists of two decimal digits in one byte. But packed-to-unpacked conversion results in two unpacked BCD bytes. Each unpacked BCD byte has one digit in the lower four bits and zero filling the upper four bits.



(3) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.



(4) Program List

```

;*****
;
;           Packed BCD -> unpacked BCD
;
;*****
;
PTOUP:
    LDX     #ADDRPT
    LDA     0,X           ;Get packed BCD data
    SET                     ;T flag set
    AND     #0FH         ;Unpacked BCD data L
    CLT                     ;T flag clear
    AND     #0F0H
    INX
    JSR     SWAPA         ;Swap A
    STA     0,X           ;Unpacked BCD data H
    RTS

;*****
;
;           Swap A register
;
;*****
;
SWAPA:
    CLT                     ;T flag clear
    CLD                     ;Decimal mode clear
    LDY     #4

SWAPA1:
    ASL     A
    ADC     #0
    DEY
    BNE     SWAPA1
    RTS

```

4.4 Code Conversion (unpacked BCD → packed BCD)

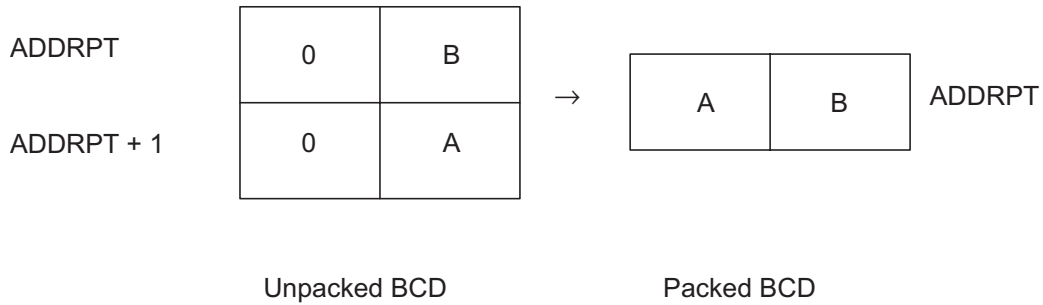
(1) Description

Unpacked BCD data is converted to packed BCD data.

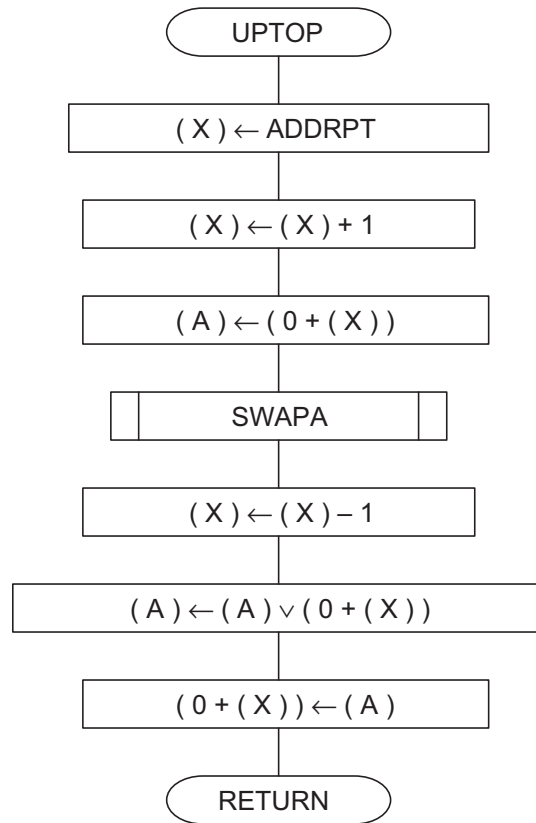
(2) Explanation

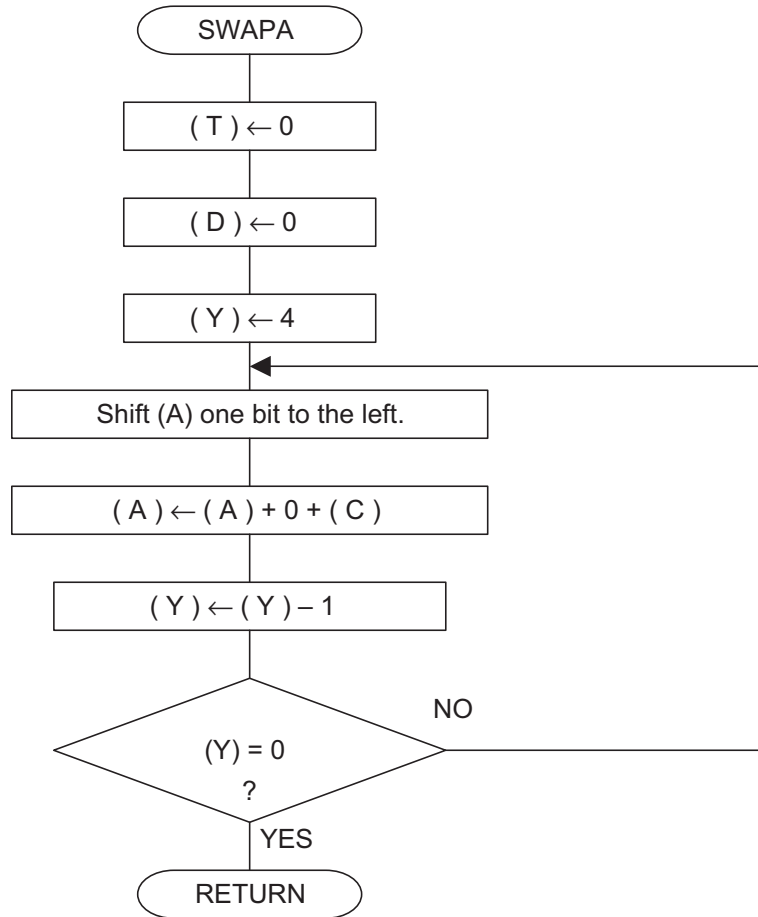
The unpacked BCD data at zero page RAM address ADDRPT +1 and ADDRPT are converted to the packed BCD data and stored at ADDRPT.

A packed BCD consists of two decimal digits in one byte. But packed-to-unpacked conversion results in two unpacked BCD bytes. Each unpacked BCD byte has one digit in the lower four bits and zero filling the upper four bits.



(3) Flowchart





(4) Program List

```

;*****
;
;           Unpacked BCD -> packed BCD
;
;*****
;
UPTOP:
    LDX      #ADDRPT
    INX
    LDA      0,X           ;Get unpacked BCD data H
    JSR      SWAPA        ;Swap A
    DEX
    ORA      0,X           ;Packed BCD data
    STA      0,X
    RTS

;*****
;
;           Swap A register
;
;*****
;
SWAPA:
    CLT                ;T flag clear
    CLD                ;Decimal mode clear
    LDY      #4

SWAPA1:
    ASL      A
    ADC      #0
    DEY
    BNE      SWAPA1
    RTS

```

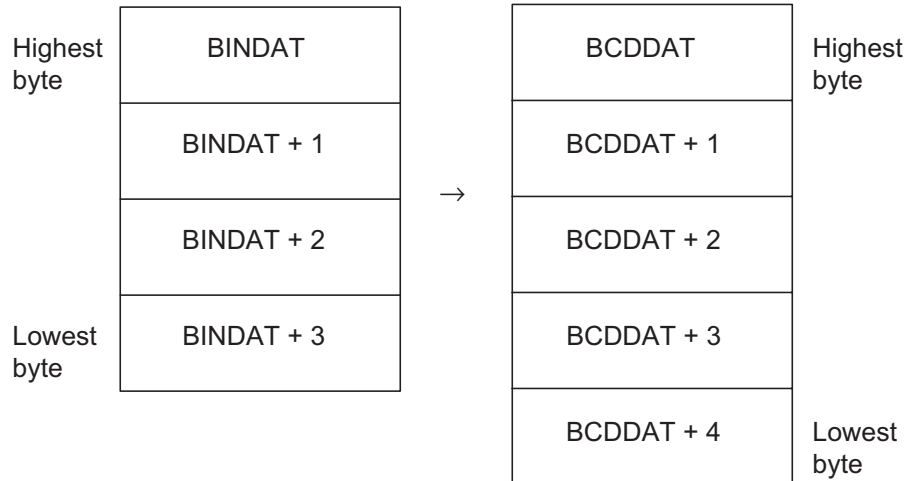

4.5 Code Conversion (BIN → BCD)

(1) Description

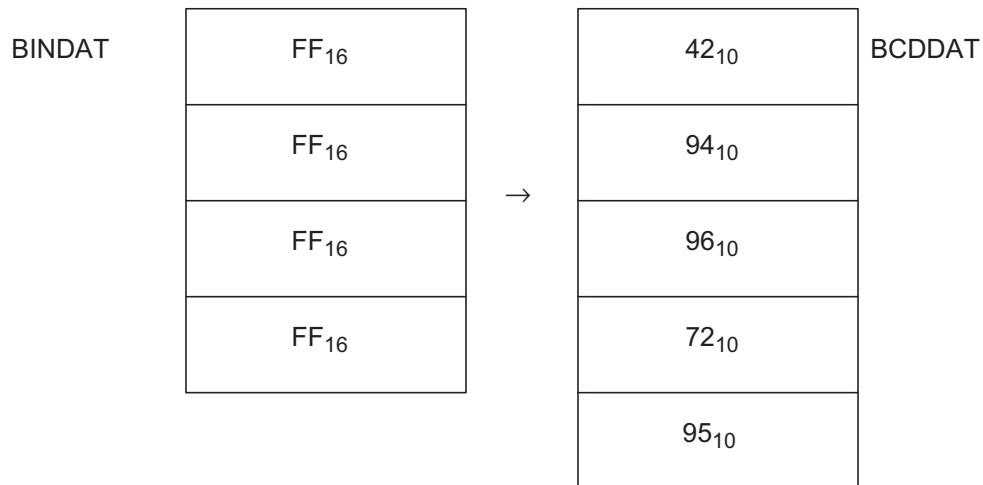
4-byte BIN data is converted to 5-byte BCD data.

(2) Explanation

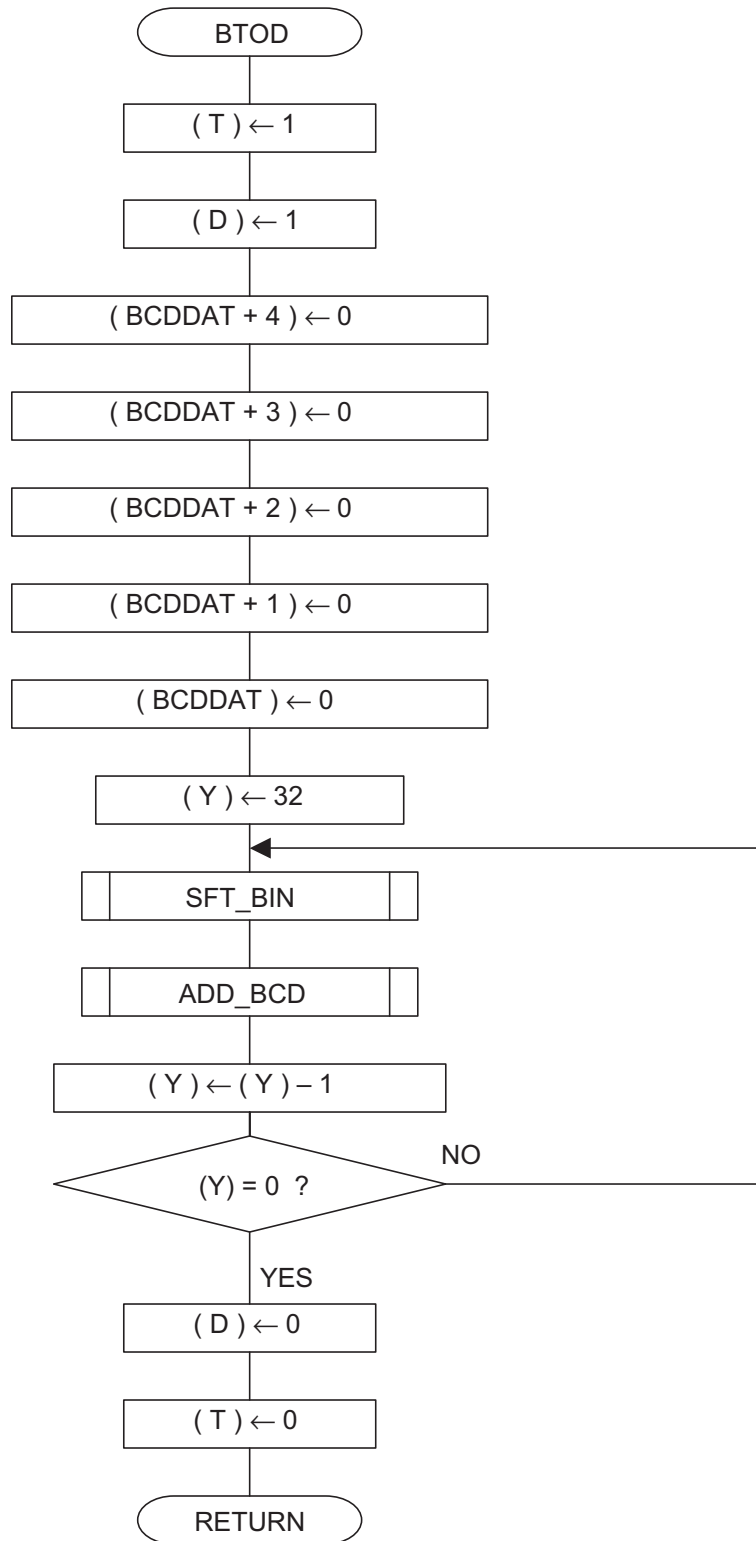
The 4-byte BIN data at zero page RAM address BINDAT, BINDAT +1, BINDAT +2, and BINDAT +3 are converted to 5-byte BCD data and stored at BCDDAT, BCDDAT +1, BCDDAT +2, BCDDAT +3 and BCDDAT +4, respectively.

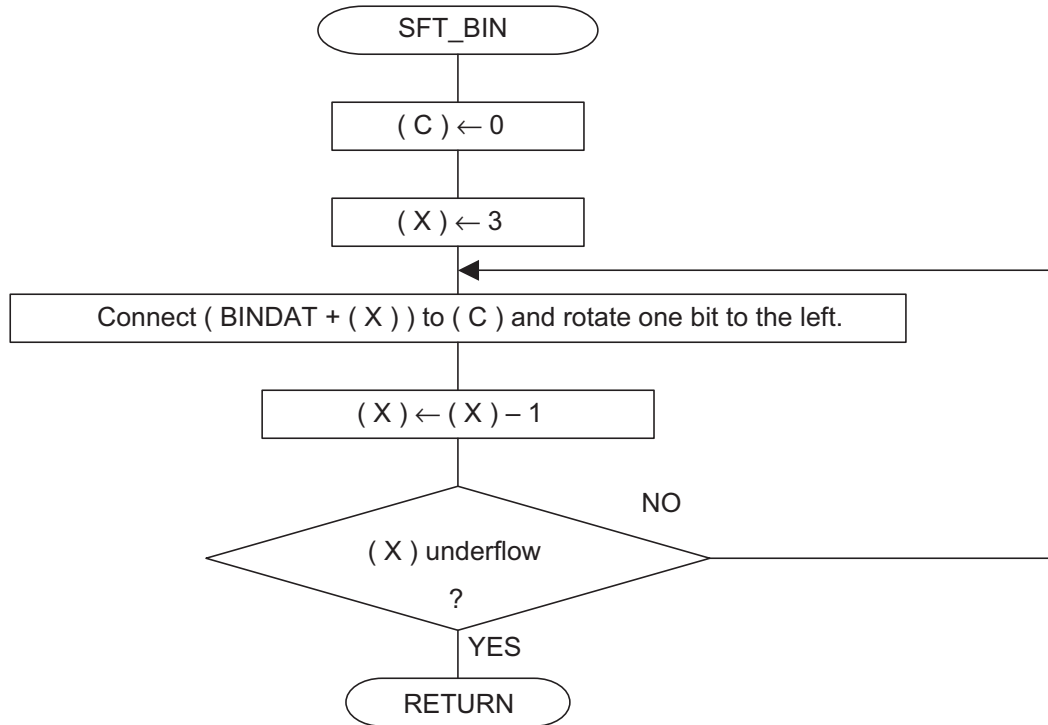


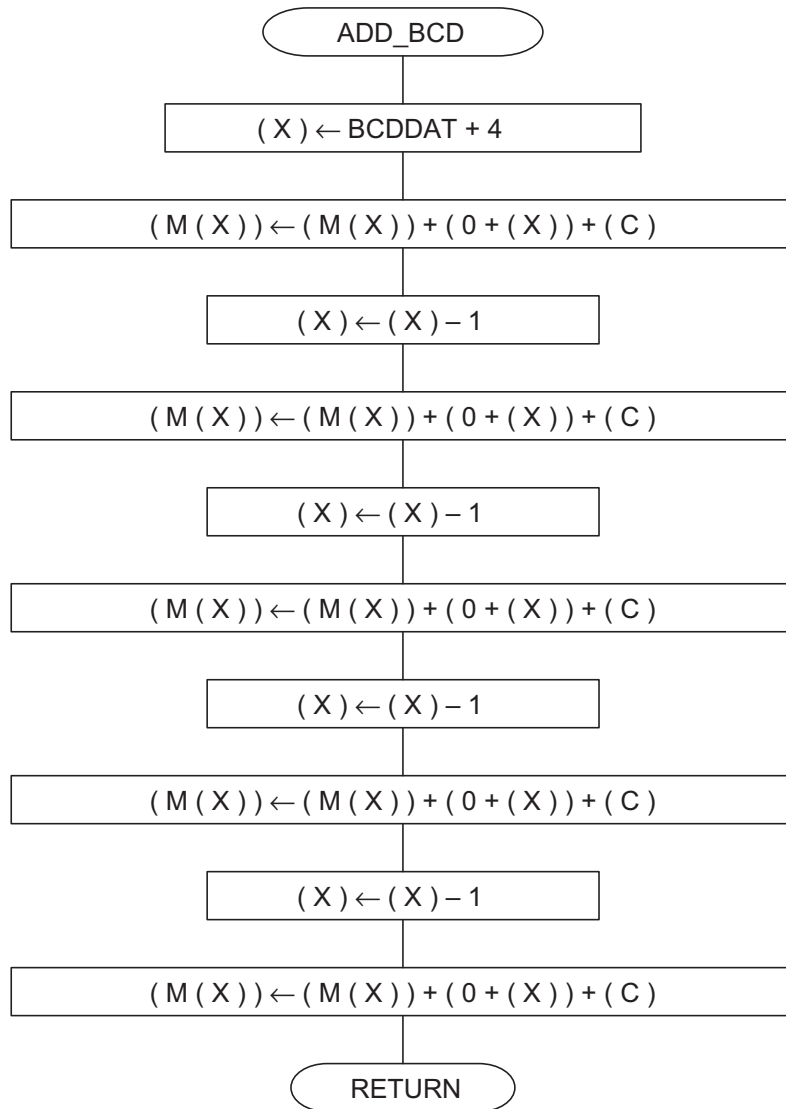
Example: If the BIN data is FFFFFFFFH, the BCD data will be 4294967295.



(3) Flowchart







Note: M (X) represents the memory of the address indicated by Index Register X.

(4) Program List

```

;*****
;
;           BIN -> BCD
;
;*****
BTOD:
    SET             ;T flag set
    SED             ;Decimal mode set
    LDM             #0,BCDDAT+4      ;Clear BCD result area
    LDM             #0,BCDDAT+3
    LDM             #0,BCDDAT+2
    LDM             #0,BCDDAT+1
    LDM             #0,BCDDAT
    LDY             #32             ;Yes
BTOD_01:
    JSR             SFT_BIN          ;Left shift BIN data
    JSR             ADD_BCD          ;2*(BCD)+C -> (BCD)
    DEY
    BNE             BTOD_01          ;Convert end ?
    CLD
    CLT             ;T flag clear
    RTS
;*****
;
;           Left shift BIN data
;
;*****
SFT_BIN:
    CLC             ;C flag clear
    LDX             #3
SFT_01:
    ROL             BINDAT,X
    DEX
    BPL             SFT_01           ;Shift end ?
    RTS             ;Yes
;*****
;
;           2*(BCD)+C -> (BCD)
;
;*****
ADD_BCD:
    LDX             #BCDDAT+4
    ADC             0,X
    DEX
    ADC             0,X
    DEX
    ADC             0,X
    DEX
    ADC             0,X
    DEX
    ADC             0,X
    DEX
    RTS

```

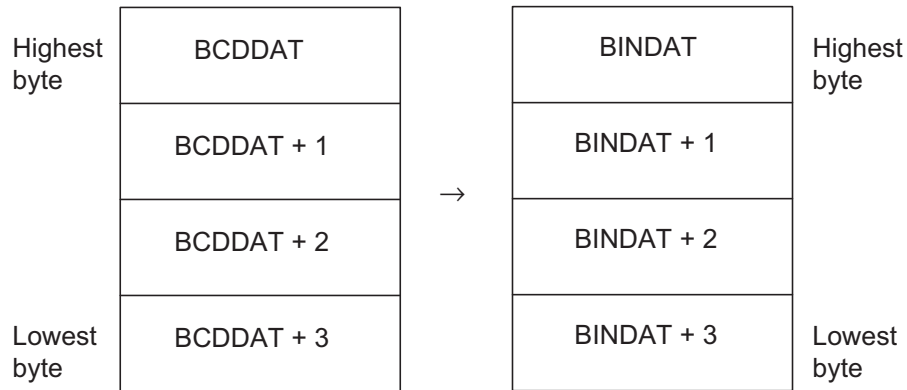
4.6 Code Conversion (BCD → BIN)

(1) Description

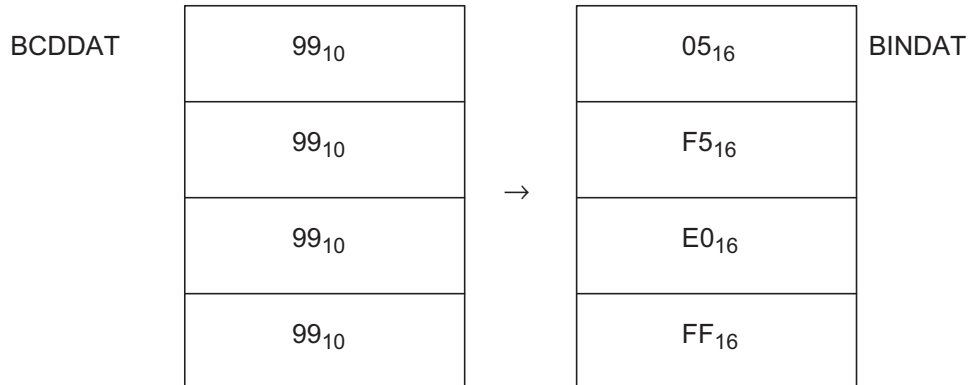
4-byte BCD data is converted to 4-byte BIN data.

(2) Explanation

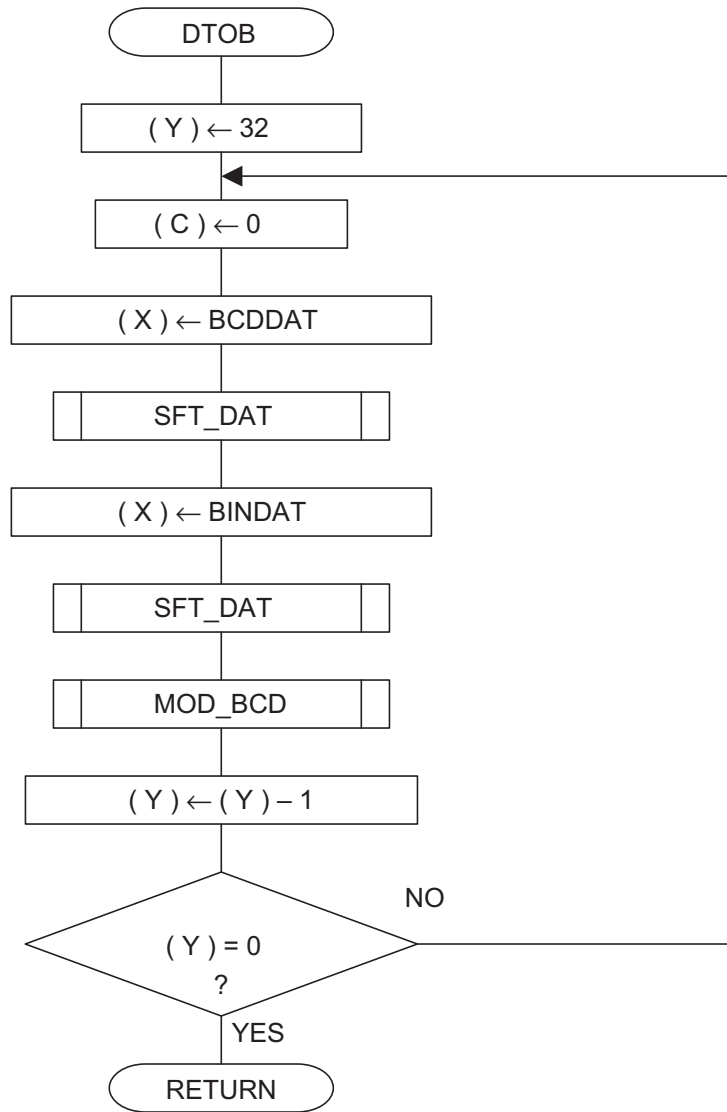
The 4-byte BCD data at zero page RAM addresses BCDDAT, BCDDAT +1, BCDDAT +2, and BCDDAT +3 are converted to 4-byte BIN data and stored at BINDAT, BINDAT +1, BINDAT +2, and BINDAT +3, respectively.

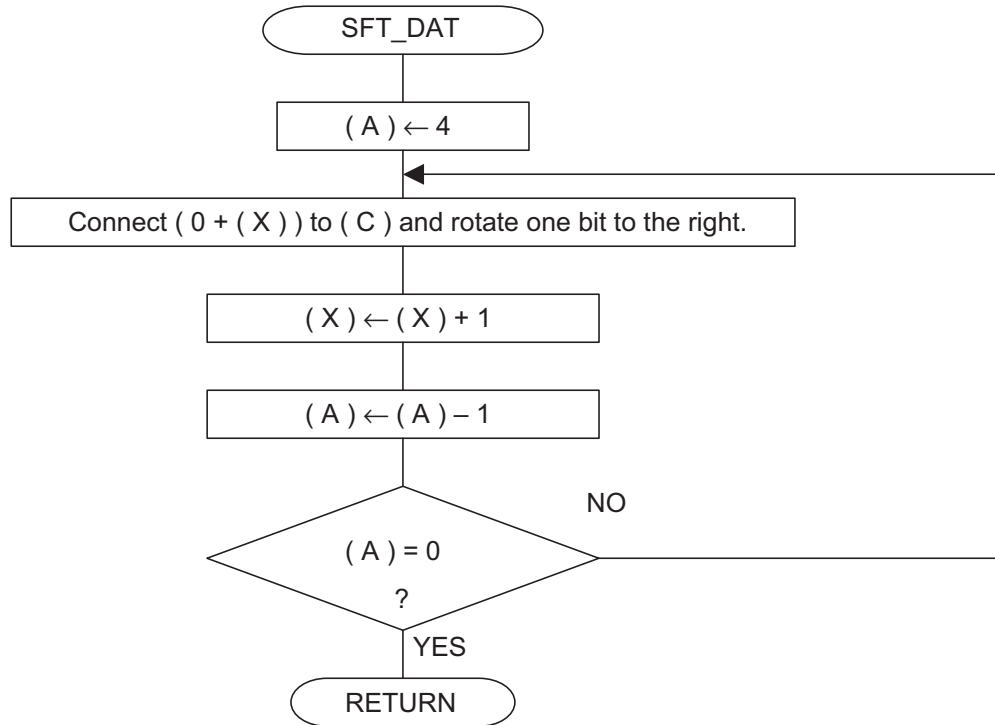


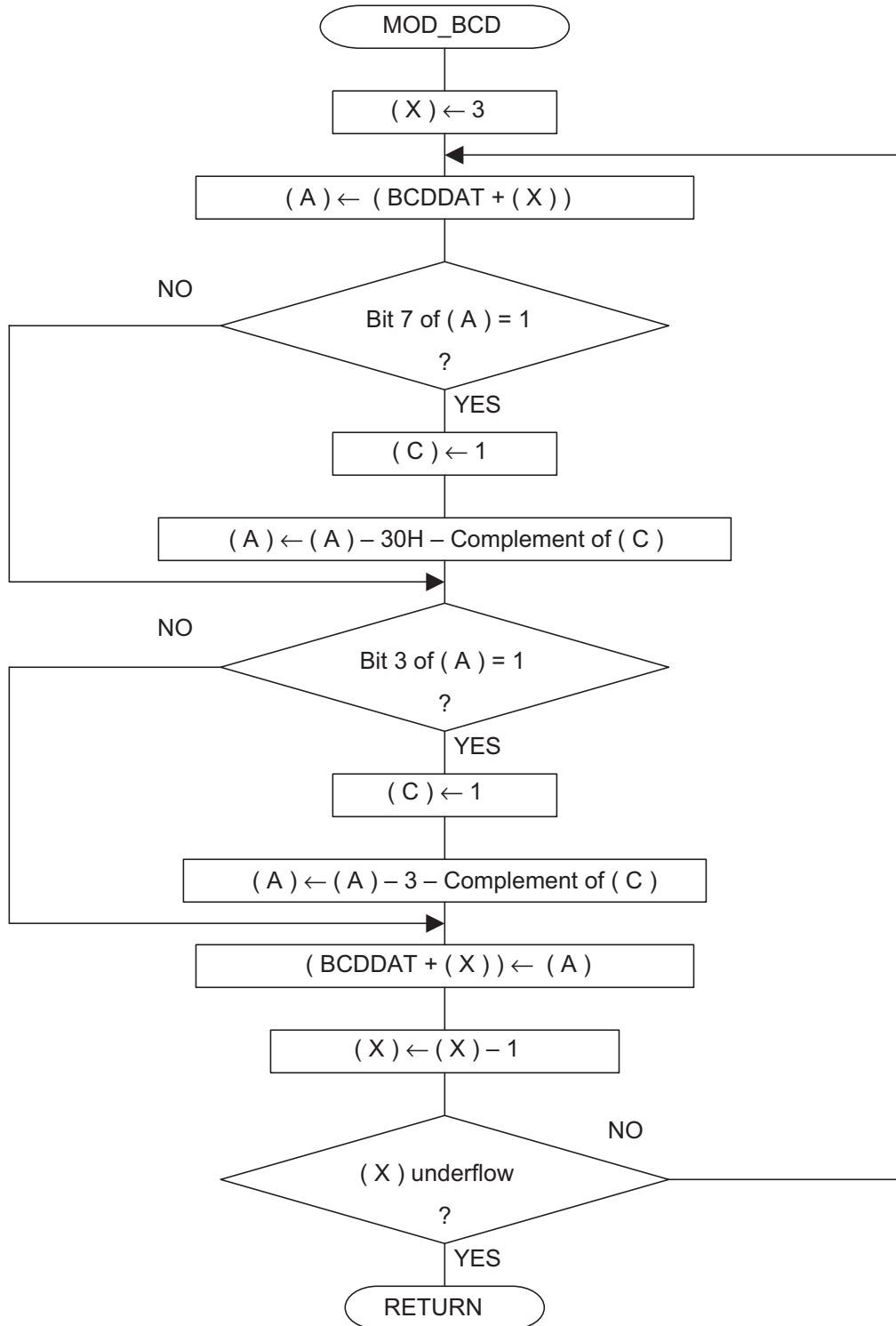
Example: If the BCD data is 99999999, the BIN data will be 05F5E0FFH.



(3) Flowchart







(4) Program List

```

;*****
;
;           BCD -> BIN
;
;*****
DT0B:
        LDY          #32
DT0B_01:
        CLC
        LDX          #BCDDAT           ;Point to BCDDAT
        JSR          SFT_DAT           ;Right shift BCD data
        LDX          #BINDAT           ;Point to BINDAT
        JSR          SFT_DAT           ;Right shift BIN data
        JSR          MOD_BCD           ;Get modified BCD data
        DEY
        BNE          DT0B_01           ;Shift end ?
        RTS          ;Yes !
;*****
;
;           Right shift data
;
;*****
SFT_DAT:
        LDA          #4
SFT_02:
        ROR          0,X
        INX
        DEC          A
        BNE          SFT_02
        RTS
;*****
;
;           Modify BCD data
;
;*****
MOD_BCD:
        LDX          #3
MOD_01:
        LDA          BCDDAT,X
        BBC          7,A,MOD_02
        SEC
        SBC          #30H
MOD_02:
        BBC          3,A,MOD_03
        SEC
        SBC          #3
MOD_03:
        STA          BCDDAT,X
        DEX
        BPL          MOD_01
        RTS

```

4.7 SGN Function

(1) Description

This is the SGN function for Accumulator A.

(2) Explanation

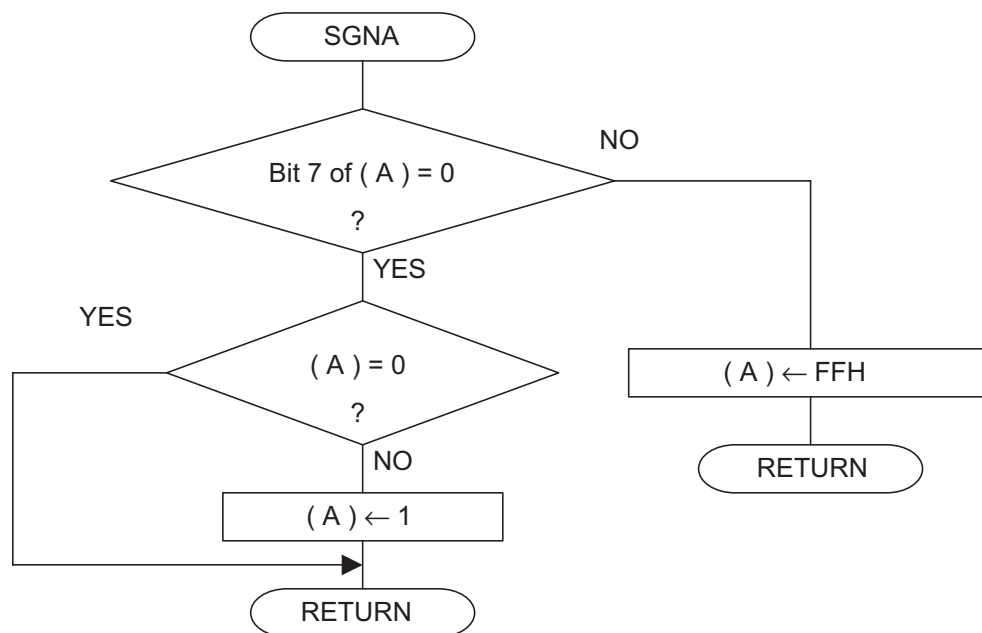
The SGN value for the contents of Accumulator A is figured and stored into Accumulator A. Bit 7 of Accumulator A is a sign bit. The SGN function for this operation is as follows:

When $(A) > 0$, $SGN(A) = 1$

When $(A) = 0$, $SGN(A) = 0$

When $(A) < 0$, $SGN(A) = -1$

(3) Flowchart



(4) Program List

```

;*****
;
;           SGN(A)
;
;*****
;
SGNA:
    BBS     7,A,SGN_01
    CMP     #0
    BEW     SGN_02
    LDA     #1

SGN_02:
    RTS

SGN_01:
    LDA     #$FF
    RTS
  
```

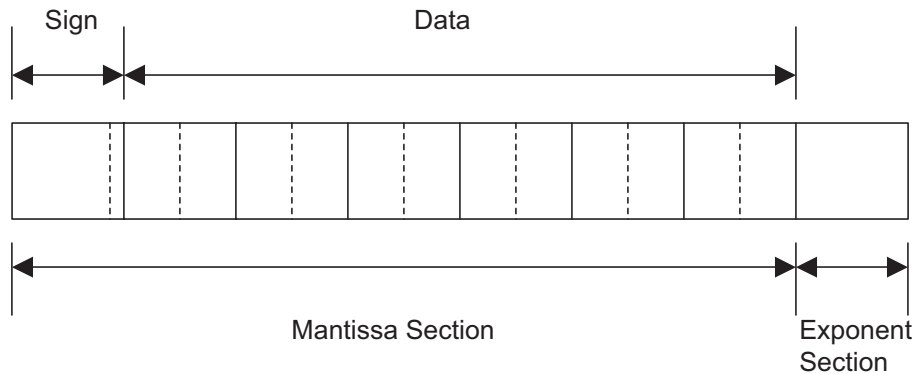
4.8 BCD 12-digit Floating Point Arithmetic Calculations

(1) Description

Arithmetic calculations for BCD 12-digit floating point numbers are performed.

(2) Explanation

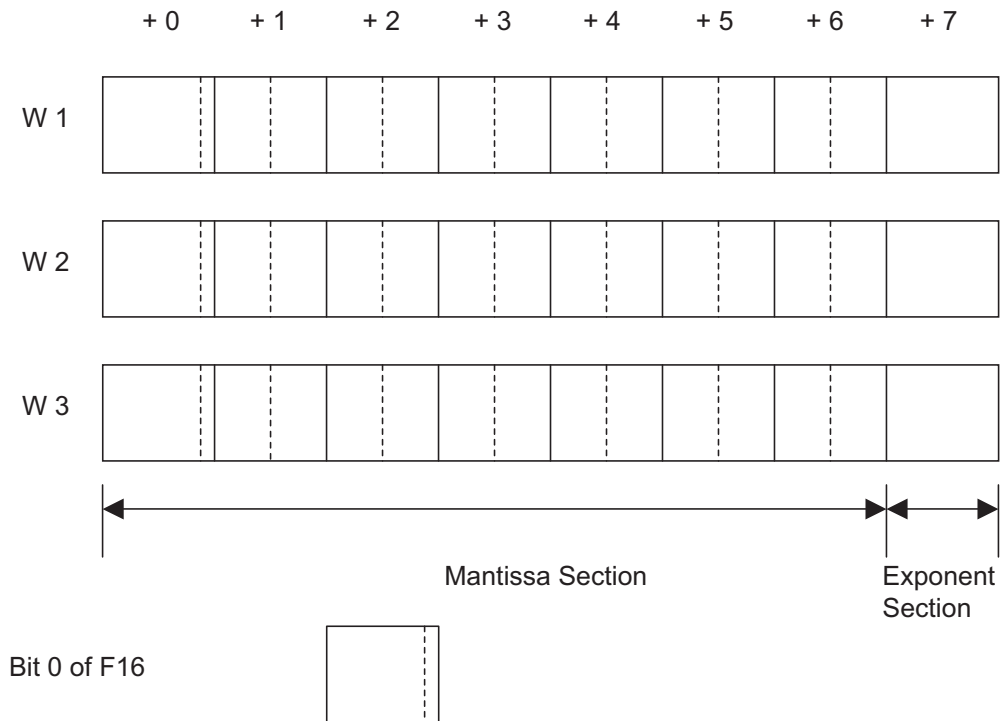
The data format, as shown below, consists of two sections: the mantissa (7 bytes: 1 byte of sign bit, 6 bytes of data) and the exponent (one byte). “0” indicates a positive mantissa sign; “1” indicates a negative mantissa sign. The mantissa section data consists of 12 digits of valid numerical numbers (BCD). The exponent section can only handle values ranging from 00H to 0CH; the results of the calculation cannot be guaranteed for values ranging from 0DH to FFH.



The following are examples of numbers expressed in this format.

1234	0							1	2	3	4	00
1.234	0							1	2	3	4	03
- 15000	1							1	5	0	0	00
- 0.999999999999	1	9	9	9	9	9	9	9	9	9	9	0C

This format is used by the following three files in the zero page RAM area: W1, W2, and W3.



- W1: Stores the number to be operated and the results.
- W2: Stores the operand. Address is $W2 = W1 + 8$.
- W3: Uses as a work file for multiply and divide operations. Address is $W3 = W2 + 8$.
- Bit 0 of F16: Goes to "1" when error occurs.

The following shows the calling sequence for each arithmetic operation. Note that add and subtract are determined by the value in bit 3 of W2.

- Multiply:
 - (a) Set the number to be operated in W1.
 - (b) Set the operand in W2.
 - (c) JSR MULT

- **Divide:**
Steps (a) & (b) are the same as those in the Multiply operation.
(c) JSR DIV
- **Add:**
Steps (a) & (b) are the same as those in the Multiply operation.
(c) JSR ADSB
- **Subtract:**
Steps (a) & (b) are the same as those in the Multiply operation.
(c) Set bit 3 of W2 to “1”.
(d) JSR ADSB

After these processes are executed, the results can be checked for errors with the data in bit 0 of zero page RAM address F16. If bit 0 of F16 = “1”, an error has occurred. Errors that may occur in these operations are described below.

Operation	Error
Add	When the result exceeds 999999999999
Subtract	When the result exceeds – 999999999999
Multiply	When the result exceeds ± 999999999999
Divide	<ul style="list-style-type: none"> • When it is divided by 0 • When the result exceeds ± 999999999999

(3) Program List

```

;*****
;
;      12 digits BCD number addition,subtraction
;      ,multiplication,division
;
;*****
;
;      RAM ASSIGN
;
;      0      1      2      3      4      5      6      7
;W1:SIGN MSD<-----LSD  INDX
;W2:SIGN MSD<-----LSD  INDX
;W3:SIGN MSD<-----LSD  INDX
;
;
;*****
;
;      W1 <- W1/W2
;
;*****
;
DIVI:
      JSR      BFITL          ;W3<-W1 copy,W1<-0
      SBC      8,X           ;D=0,T=1,W1 INDX<-W1 INDX-W2 INDX
      AND      #0FH         ;W1 INDX MSD clear
      SEB      0,F16
      BCC      DIV1         ;W1 INDX<W2 INDX?
      CLB      0,F16        ;No
DIV1:  CLT
      SED
      JSR      SUB0         ;W1<-W1-W2
      BCS      DIV2         ;Borrow arise ?
      TST
      BEQ      DIV3         W1 ;Yes,then test W1
      DEC      W1
DIV2:  CLD                  ;Binary mode
      RRF      W3+6
      CLC
      LDA      W3+6
      ADC      #10H
      STA      W3+6         ;W3 LSD<-W3 LSD+1
      RRF      W3+6
      BCC      DIV1         ;W3 LSD>=15 ?
ERROR: SEB      0,F16       ;0 Division error
      CLD                  ;Decimal mode clear
      RTS
;
DIV3:  JSR      ADD0         ;W1<-W1+W2,add back
      LDA      W3+7
      CMP      #12
      BCS      DIV6
      INC      W3+7

```

```

;
DIV4:   LDY      #4           ;W1 MSD<--W1 LSD<--W3 MSD<--W3 LSD
DIV5:   LDX      #6           ;4 bits left rotate
        CLC
DIV51:  ROL      W3,X
        DEX
        BNE     DIV51
        LDX     #6
        LDA     #7
DIV52:  ROL      W1,X
        DEX
        DEC     A
        BNE     DIV52
        DEY
        BNE     DIV5           ;Rotate end ?
        INX
        SET     ;T flag set
        AND     #0FH
        BRA     DIV1
;
DIV6:   LDA     W3+1
        AND     #0F0H
        BNE     DIV10
        BBS     0,F16,DIV7
        LDA     W1+7
        CMP     #12
        BCS     DIV10
DIV7:   INC     W1+7
        BBC     4,W1+7,DIV41
        CLB     4,W1+7
        CLB     0,F16
DIV41:  BRA     DIV4
ERROR1: BRA     ERROR
;
DIV10:  BBS     0,F16,ERROR   ;Over flow error
        LDA     W1+7
        CMP     #13
        BCS     ERROR       ;Under flow error
DIV12:  LDY     #7           ;W1<-W3 copy
        LDX     #W1
        SET     ;T<-1
DIV15:  LDA     16,X
        INX
        DEY
        BNE     DIV15
;

```



```

CLT                                ;T<-0
JSR      INDX                      ;"0" condense
CLD                                ;Decimal mode clear
CLC
LDA      W1
ADC      W2
STA                                W1 ;Get sign bit
CLB      0,F16                     ;Normal return
RTS

;*****
;
;      W1 <- W1*W2
;
;*****
MULT:
JSR      BFITL                     ;W3 <- W1 copy,W1 clear
CLC                                ;C flag clear
ADC      8,X                       ;W1_INDX <- W1_INDX+W2_INDX
CLB      0,F16
BEC      4,W1+7,MULT2              ;W1_INDX <- W_INDX+W2_INDX
SEB      0,F16                     ;Yes
CLB      4,W1+7

MULT2:
CLT                                ;T flag clear

MULT7:
LDA      W3+6
AND      #$0F
BNE      MULT3
INC      W3+7                       ;W1_MSD -> W1_LSD -> W3_MSD -> W3_LSD

MULT9:
LDY      #4

MULT6:
LDX      #0
LDA      #7
CLC

MULT4:
ROR      W1,X
INX
DEC      A
BNE      MULT4
LDX      #1
LDA      #6

MULT5:
ROR      W3,X
INX
DEC      A
BNE      MULT5
DEY
BNE      MULT6                     ;4 bits right rotate end ?
LDA      W3+7
CMP      #12
BCC      MULT7
BBS      0,F16,MULT8
LDX      #W1+1                     ;W1 "0" test

```

```

MULT81:
    LDA    0,X
    BNE    MULT8
    INX
    CPX    #W1+7
    BNE    MULT81
    BRA    DIV12                ;Get result (to division routine)

MULT8:
    LDA    W1+7
    BNE    MULT10
    BBC    0,F16,ERROR1        ;Overflow error
    CLB    0,F16

MULT10:
    DEC    W1+7
    LDA    W1+7
    AND    #$0F
    STA    W1+7
    BRA    MULT9

MULT3:
    DEC    W3+6
    SED
    JSR    ADD0
    BCC    MULT31
    INC    W1

MULT31:
    BRA    MULT2
;*****
;
;    W1 <- W1-W2
;
;*****
;
SUB0:
    SEC
    LDA    #6
    LDX    #W1+6
    SET                    ;T flag set

SUB01:
    SBC    8,X
    DEX
    DEC    A
    BNE    SUB01
    CLT                    ;T flag clear
    RTS

```

```

;*****
;
;      W1 <- W1+W2
;
;*****
;
ADD0:
      CLC
      LDA      #6
      LDX      #W1+6
      SET                      ;T flag set
ADD01:
      ADC      8,X
      DEX
      DEC      A
      BNE      ADD01
      CLT                      ;T flag clear
      RTS
*****
;
;      Following "0" condense,then modify INDX and data
;
;*****
;
INDX:
      TST      W1+7              ;Test W1 INDX
      BEQ      INDX1
      LDA      W1+6
      AND      #$0F
      BNE      INDX1            ;Valid data remain ?
      LDX      #W1              ;No
      JSR      SFR4            ;Condense to LSB direction
      DEC      W1+7            ;Modify INDX
      BRA      INDX            ;again
INDX1:
      RTS
;*****
;
;      W1 -> W3 ,and 0 -> W1
;
;*****
;
BFITL:
      CLT
      LDX      #W1

```

```

BFITL1:
    LDA    0,X
    STA    16,X
    LDA    #0
    STA    0,X
    INX
    CPX    #W1+7
    BNE    BFITL1
    LDM    #0,W3+7           ;W3_INDX initial
    CLD                    ;Decimal mode clear
    SET                    ;T flag set
    RTS

;*****
;
;    WN 4 bits left shift
;
;*****
;
SFL4:
    LDA    #4
SFL41:
    ASL    6,X
    ROL    5,X
    ROL    4,X
    ROL    3,X
    ROL    2,X
    ROL    1,X
    DEC    A
    BNE    SFL41
    RTS

;*****
;
;    WN 4 bits right shift
;
;*****
;
SFR4:
    LDA    #4
SFR41:
    LSR    1,X
    ROR    2,X
    ROR    3,X
    ROR    4,X
    ROR    5,X
    ROR    6,X
    DEC    A
    BNE    SFR41
    RTS

```

```

;*****
;
;       Adjust INDX to W1 to W2
;
;*****
;
ADIX:
        LDA      W1+7
        CMP      W2+7
        BEQ      ADIX1
        BCC      ADIX23

ADIX22:
        LDX      #W2

ADIX2:
        LDA      1,X
        AND      #$F0
        BEQ      ADIX21
        CPX      #W1
        BEQ      ADIX51
        LDX      #W1

ADIX5:
        JSR      SFR4
        DEC      7,X
        BRA      ADIX

ADIX23:
        LDX      #W1
        BRA      ADIX2

ADIX51:
        LDX      #W2
        BRA      ADIX5

ADIX21:
        JSR      SFL4
        INC      7,X
        BRA      ADIX

ADIX1:
        RTS

;*****
;
;       Execute addition,subtraction
;
;*****
;
ADSB:
        SED                      ;Decimal mode set
        CLT                      ;T flag clear
        JSR      ADIX             ;Adjust INDX

ADSB1:
        BBS      3,W2,ADSB6
        BBS      0,W1,ADSB7
        BBS      0,W2,ADSB10

```

```

ADSB9:
    JSR    ADD0                ;W2 <- W1+W2
    BCC    ADD2                ;C arise ?
    SEB    0,F16              ;Yes
    JSR    SFR4                ;1 digit right shift
    DEC    W1+7                ;INDX -1
    BMI    ADD3                ;FF ?
    CLC                    ;No
    LDA    W1+1
    ADC    #$10
    STA    W1+1

ADD2:
    CLB    0,F16
    JSR    INDX

ADD3:
    CLD                    ;Decimal mode clear
    RTS

ADSB7:
    BBS    0,W2,ADSB9

ADSB10:
    JSR    SUB0                ;W1 <- W1-W2
    BCS    SUB2
    INX

SUB3:
    LDA    #$99
    SEC
    SBC    0,X
    STA    0,X                ;Get 99-X
    INX
    CPX    #W1+7
    BNE    SUB3
    DEX
    SET
    LDY    #6                ;C=1

SUB4:
    ADC    #0
    DEX
    DEY
    BNE    SUB4
    CLT                    ;Get 100's complement
    COM    W1                ;Get sign bit in bit0

SUB2:
    CLB    0,F16
    JSR    INDX
    CLD                    ;Decimal mode clear
    RTS

ADSB6:
    BBS    0,W1,ADSB11
    BBS    0,W2,ADSB9
    BRA    ADSB10

ADSB11:
    BBS    0,W2,ADSB10
    BRA    ADSB9

```

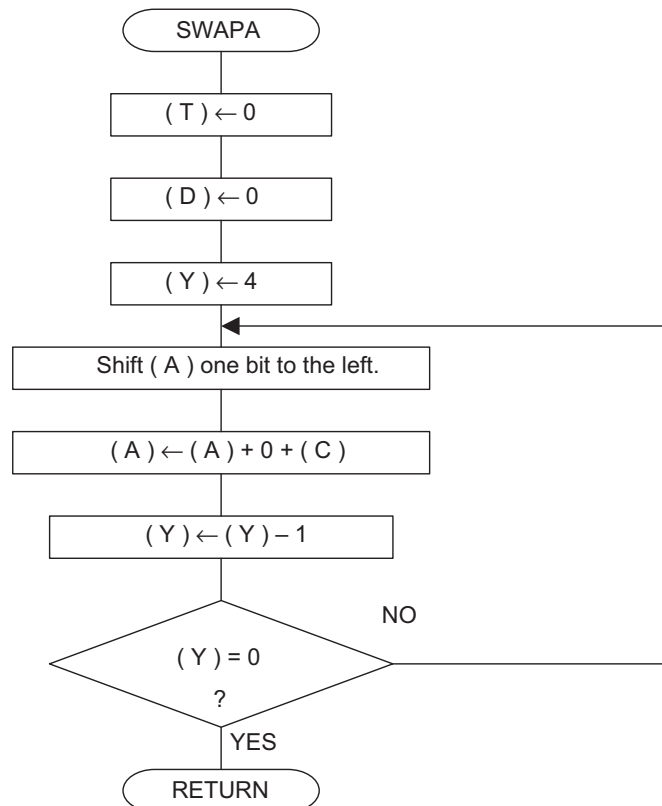
5. Substitute Instruction

5.1 Swap Accumulator

(1) Description

Accumulator A's upper four bits are swapped with the lower four bits.

(2) Flowchart



(3) Program List

```

;*****
;
;      Swap A register
;
;*****
;
SWAPA:
    CLT                ;T flag clear
    CLD                ;Decimal mode clear
    LDY                #4

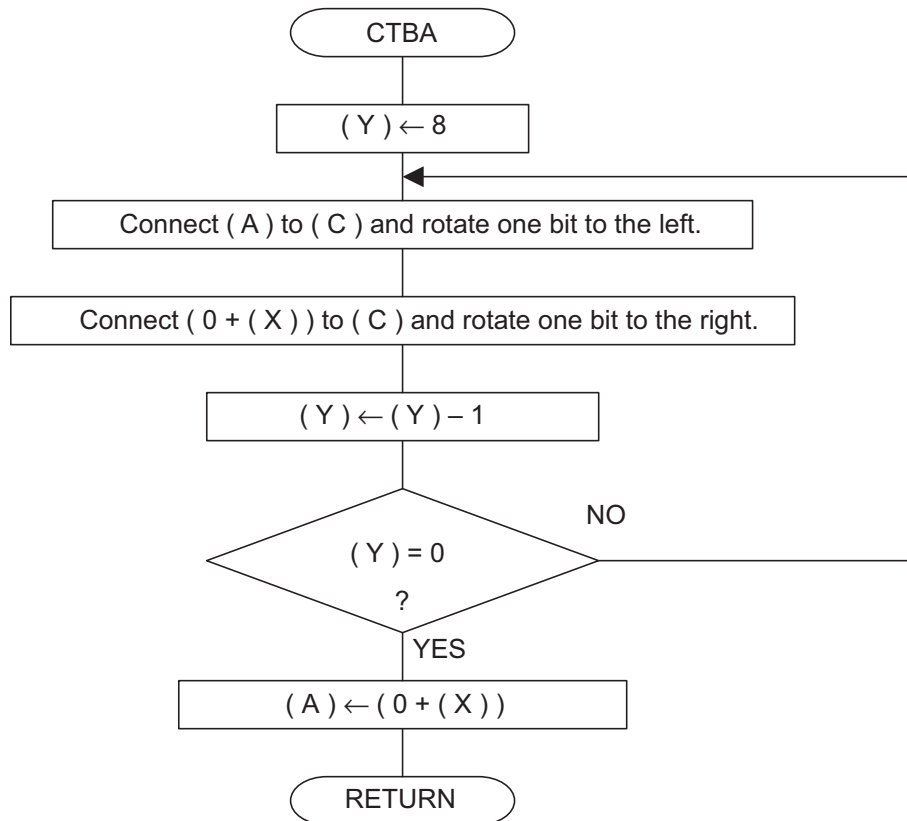
SWAPA1:
    ASL                A
    ADC                #0
    DEY
    BNE                SWAPA1
    RTS
  
```

5.2 Counter Bit Accumulator

(1) Description

The order of Accumulator A's bit data is reversed, using one byte of the work memory specified by Index Register X.

(2) Flowchart



(3) Program List

```

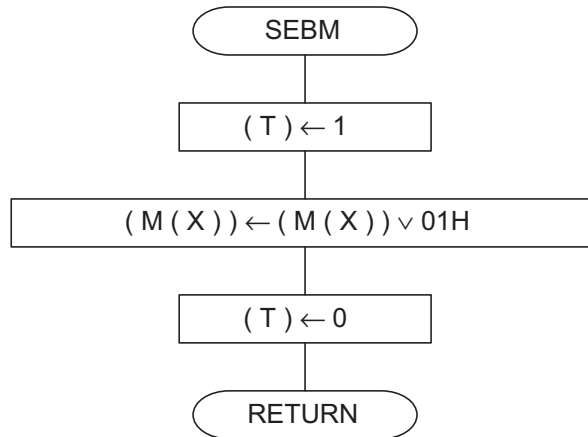
;*****
;
;      Counter bit A register
;
;*****
;
CTBA:
    LDY      #8
CTBA1:
    ROL      A
    ROR      0,X
    DEY
    BNE      CTBA1
    LDA      0,X
    RTS
  
```


5.3 Memory Set Bit

(1) Description

Bit 0 of the memory specified by Index Register X is set to "1".

(2) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(3) Program List

```

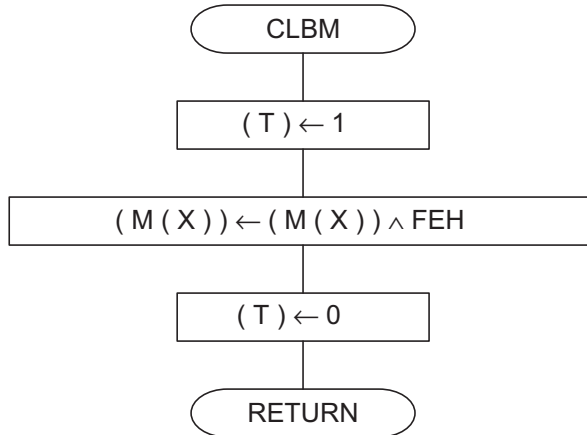
;*****
;
;      Set bit 0 of M(X)
;
;*****
;
SEBM:
    SET          ;T flag set
    ORA         #1      ;Bit 0 set
    CLT         ;T flag clear
    RTS
  
```

5.4 Memory Clear Bit

(1) Description

Bit 0 of the memory specified by Index Register X is set to “0”.

(2) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(3) Program List

```

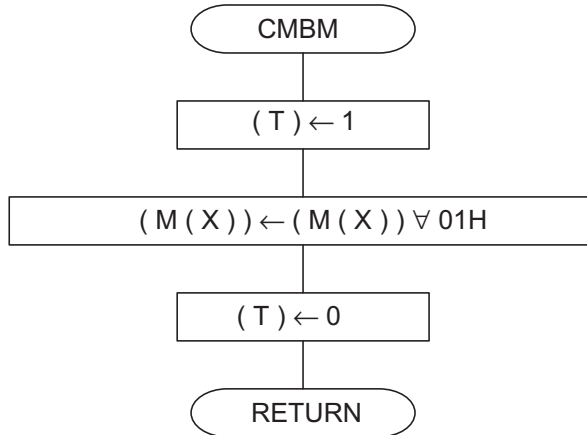
;*****
;
;      Clear bit 0 of M(X)
;
;*****
;
CLBM:
    SET          ;T flag set
    AND          #$FE      ;Bit 0 clear
    CLT          ;T flag clear
    RTS
  
```

5.5 Memory Bit Reversal

(1) Description

Bit 0 of the memory specified by Index Register X is reversed.

(2) Flowchart



Note: M (X) represents the memory of the address indicated by Index Register X.

(3) Program List

```

;*****
;
;      Complement bit 0 of M(X)
;
;*****
;
CMBM:
    SET          ;T flag set
    EOR         #1      ;Bit 0 complement
    CLT          ;T flag clear
    RTS
  
```

6. Program Usage Notes

The following usage notes apply to 740 Family products, in addition to all the instructions provided in the 740 Family Software Manual.

- (1) The user must always perform thorough system evaluations.
- (2) The program automatically handles X Modified Operation Mode Flag T and Decimal Mode Flag D as “0”. Do not call up this routine with either flag set to “1”.
- (3) When executing the ADC or SBC instructions in the decimal mode (D = “1”), the processor status register’s Negative Flag N, Overflow Flag V and Zero Flag Z become invalid. In addition, Carry Flag C is set to “1” when the results of the operation generate a “carry”, and cleared to “0” when the results generate a “borrow”.
- (4) In the decimal mode (D = “1”) and after execution of the ADC or SBC instruction, execute another instruction before execution of the SEC, CLC or CLD instruction.

7. Reference

Software Manual

740 Family Software Manual

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Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Feb.21.01	—	Issue as sample programs collection
1.01	Mar.18.05	—	Change to application note format and issue

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